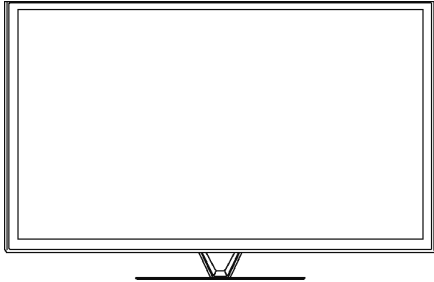


Service Manual

55 inch Class 1080p Plasma HDTV

Model No. **TC-P55VT60**

GPF16DU Chassis



For detailed troubleshooting information and circuit explanations, refer to the "QSM/Service Hints/Troubleshooting Information(TI)" and Seminar/Training Manual/Technical Guide(TG) documents posted on the TSN web site.

For information about this model, type TC-P2013 in the model box under "Direct Search".

WARNING

This service information is designed for experienced repair technicians only and is not designed for use by the general public. It does not contain warnings or cautions to advise non-technical individuals of potential dangers in attempting to service a product. Products powered by electricity should be serviced or repaired only by experienced professional technicians. Any attempt to service or repair the product or products dealt with in this service information by anyone else could result in serious injury or death.

IMPORTANT SAFETY NOTICE


There are special components used in this equipment which are important for safety. These parts are marked by  in the Schematic Diagrams, Circuit Board Diagrams, Exploded Views and Replacement Parts List. It is essential that these critical parts should be replaced with manufacturer's specified parts to prevent shock, fire or other hazards. Do not modify the original design without permission of manufacturer.

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1 Safety Precautions

1.1. General Guidelines

1. When conducting repairs and servicing, do not attempt to modify the equipment, its parts or its materials.
2. When wiring units (with cables, flexible cables or lead wires) are supplied as repair parts and only one wire or some of the wires have been broken or disconnected, do not attempt to repair or re-wire the units. Replace the entire wiring unit instead.
3. When conducting repairs and servicing, do not twist the Fasten connectors but plug them straight in or unplug them straight out.
4. When servicing, observe the original lead dress. If a short circuit is found, replace all parts which have been overheated or damaged by the short circuit.
5. After servicing, see to it that all the protective devices such as insulation barriers, insulation papers shields are properly installed.
6. After servicing, make the following leakage current checks to prevent the customer from being exposed to shock hazards.

1.1.1. Leakage Current Cold Check

1. Unplug the AC cord and connect a jumper between the two prongs on the plug.
2. Measure the resistance value, with an ohmmeter, between the jumpered AC plug and each exposed metallic cabinet part on the equipment such as screwheads, connectors, control shafts, etc. When the exposed metallic part has a return path to the chassis, the reading should be between 1Mohm and 5.2Mohm. When the exposed metal does not have a return path to the chassis, the reading must be ∞ .

1.1.2. Leakage Current Hot Check (See Figure 1.)

1. Plug the AC cord directly into the AC outlet. Do not use an isolation transformer for this check.
2. Connect a 1.5kohm, 10 watts resistor, in parallel with a 0.15 μ F capacitors, between each exposed metallic part on the set and a good earth ground such as a water pipe, as shown in Figure 1.
3. Use an AC voltmeter, with 1000 ohms/volt or more sensitivity, to measure the potential across the resistor.
4. Check each exposed metallic part, and measure the voltage at each point.
5. Reverse the AC plug in the AC outlet and repeat each of the above measurements.
6. The potential at any point should not exceed 0.75 volts RMS. A leakage current tester (Simpson Model 229 or equivalent) may be used to make the hot checks, leakage current must not exceed 1/2 milliamp. In case a measurement is outside of the limits specified, there is a possibility of a shock hazard, and the equipment should be repaired and rechecked before it is returned to the customer.

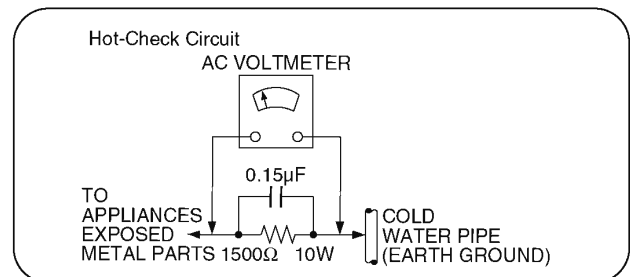


Figure 1

2 Warning

2.1. Prevention of Electrostatic Discharge (ESD) to Electrostatically Sensitive (ES) Devices

Some semiconductor (solid state) devices can be damaged easily by static electricity. Such components commonly are called Electrostatically Sensitive (ES) Devices. Examples of typical ES devices are integrated circuits and some field-effect transistors and semiconductor [chip] components. The following techniques should be used to help reduce the incidence of component damage caused by electrostatic discharge (ESD).

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any ESD on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging ESD wrist strap, which should be removed for potential shock reasons prior to applying power to the unit under test.
2. After removing an electrical assembly equipped with ES devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
3. Use only a grounded-tip soldering iron to solder or unsolder ES devices.
4. Use only an anti-static solder removal device. Some solder removal devices not classified as [anti-static (ESD protected)] can generate electrical charge sufficient to damage ES devices.
5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ES devices.
6. Do not remove a replacement ES device from its protective package until immediately before you are ready to install it. (Most replacement ES devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive material).
7. Immediately before removing the protective material from the leads of a replacement ES device, touch the protective material to the chassis or circuit assembly into which the device will be installed.

Caution

Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.

8. Minimize bodily motions when handling unpackaged replacement ES devices. (Otherwise ham less motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity (ESD) sufficient to damage an ES device).

2.2. About lead free solder (PbF)

Note: Lead is listed as (Pb) in the periodic table of elements.

In the information below, Pb will refer to Lead solder, and PbF will refer to Lead Free Solder.

The Lead Free Solder used in our manufacturing process and discussed below is (Sn+Ag+Cu).

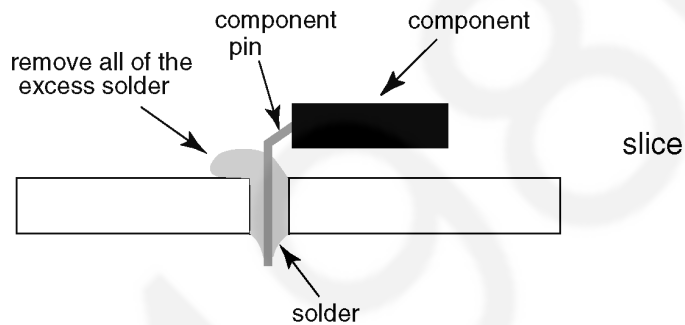
That is Tin (Sn), Silver (Ag) and Copper (Cu) although other types are available.

This model uses Pb Free solder in it's manufacture due to environmental conservation issues. For service and repair work, we'd suggest the use of Pb free solder as well, although Pb solder may be used.

PCBs manufactured using lead free solder will have the PbF within a leaf Symbol **PbF** stamped on the back of PCB.

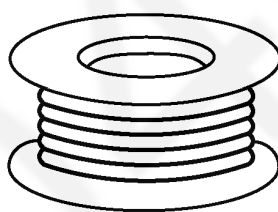
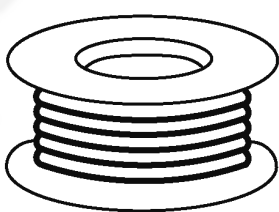
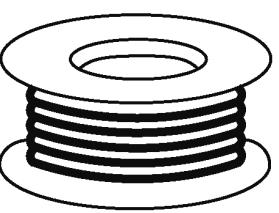
Caution

- Pb free solder has a higher melting point than standard solder. Typically the melting point is 50 ~ 70 °F (30~40 °C) higher. Please use a high temperature soldering iron and set it to 700 ± 20 °F (370 ± 10 °C).
- Pb free solder will tend to splash when heated too high (about 1100 °F or 600 °C).
If you must use Pb solder, please completely remove all of the Pb free solder on the pins or solder area before applying Pb solder. If this is not practical, be sure to heat the Pb free solder until it melts, before applying Pb solder.
- After applying PbF solder to double layered boards, please check the component side for excess solder which may flow onto the opposite side. (see figure below)



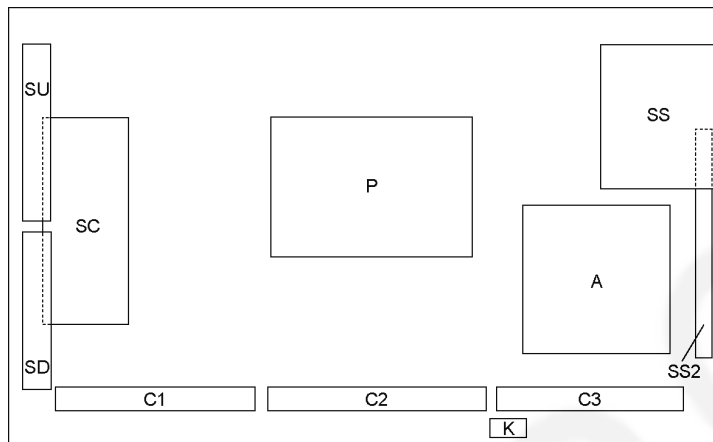
Suggested Pb free solder

There are several kinds of Pb free solder available for purchase. This product uses Sn+Ag+Cu (tin, silver, copper) solder. However, Sn+Cu (tin, copper), Sn+Zn+Bi (tin, zinc, bismuth) solder can also be used.

0.3mm X 100g	0.6mm X 100g	1.0mm X 100g
		

3 Service Navigation

3.1. PCB Layout



Board Name	Function
P	Power Supply
A	Main AV input, processing
K	Remote receiver, Power LED, C.A.T.S sensor
C1	Data Driver (Lower Right)
C2	Data Driver (Lower Center)
C3	Data Driver (Lower Left)
SC	Scan Drive
SS	Sustain Drive
SS2	Sustain out (Lower)
SU	Scan out (Upper) Non serviceable. SU-Board should be exchanged for service.
SD	Scan out (Lower) Non serviceable. SD-Board should be exchanged for service.

4 Specifications

■ TV

Power Source	AC 120 V, 60 Hz
Power Consumption	
Rated Power	472 W
Standby Power	0.2 W
Display Panel	
Panel System	Plasma Display panel
Screen size	55 inch class (55.1 inches measured diagonally)
W × H × Diagonal	48.0 inch × 27.0 inch × 55.1 inch (1,221 mm × 687 mm × 1,401 mm)
Number of pixels	1920 × 1080
Speaker Output	20 W [5 W + 5 W + 10 W] (10 % THD)
Channel Capability (Digital/Analog)	VHF/ UHF: 2 - 69, CATV: 1 - 135
Operating Conditions	
	Temperature: 32 °F - 104 °F (0 °C - 40 °C)
	Humidity: 20 % - 80 % RH (non-condensing)
Connection Terminals	
VIDEO IN	RCA PIN (VIDEO, AUDIO-L, AUDIO-R)
COMPONENT IN	RCA PIN (Y, PB, PR, AUDIO-L, AUDIO-R)
HDMI IN 1/2/3	TYPE A Connector (supports [HDAVI Control 5] function)
USB 1/2/3	USB2.0 Type A connector DC 5V, Max. 500 mA
DIGITAL AUDIO OUT	PCM / Dolby Digital, Fiber Optic
OTHERS	SD card slot, ETHERNET (10BASE-T/100BASE-TX)
Dimensions (W × H × D)	
Including pedestal	51.9 inch × 33.7 inch × 11.7 inch (1,318 mm × 855 mm × 296 mm)
TV Set only	51.9 inch × 30.2 inch × 2.0 inch (1,318 mm × 767 mm × 51 mm)
Mass	
Including pedestal	84.9 lb. (38.5 kg) NET
TV Set only	69.5 lb. (31.5 kg) NET
* With Camera pop-up: + 0.9 inch (23 mm) height	

■ Built-in Camera

Lens	F2.0 Lens; FOV (D) 50.9° (in HD mode)
Focus	Fixed focus
Resolution	1,280 × 720

■ Wireless LAN

Standard Compliance and Frequency Range *1,*2	IEEE 802.11a/n : 5.15 GHz - 5.35 GHz, 5.47 GHz - 5.85 GHz
	IEEE 802.11b/g/n : 2.400 GHz - 2.4835 GHz
Security	WPA2-PSK (TKIP/AES) WPA-PSK (TKIP/AES) WEP (64bit/128bit)

*1 The frequency and channel differ depending on the country.

*2 802.11b/g/n CH1 ~ CH11 only use for United States and Canada.

■ Bluetooth

Standard Compliance	Bluetooth® 3.0
Frequency Range	2.402GHz~2.480GHz

■ 3D Eyewear

Battery	Coin-shaped lithium battery CR2025 Operation time: Approx. 75 hours in continuous use of the battery made by Panasonic
• Use Panasonic 3D Eyewear supporting Bluetooth wireless technology.	

Note

- Design and Specifications are subject to change without notice. Mass and Dimensions shown are approximate.
- 3D Eyewear and VIERA Touch Pad Controller use Bluetooth wireless technology.

5 Technical Descriptions

5.1. Specification of KEY for DTCP-IP, WMDRM and Widevine

5.1.1. General information:

1. NAND Flash (IC8900) for spare parts has the seed of KEY for each DTCP-IP for DLNA, WMDRM for Netflix and Widevine for CinemaNow.
2. The final KEY data will be generated by Main IC (IC8000) when SELF CHECK was done and are stored in both Main IC (IC8000) and NAND Flash (IC8900).

5.1.2. Replacement of ICs:

When Main IC is replaced, NAND Flash should be also replaced with new one the same time.

When NAND Flash is replaced, Main IC is not necessary to be replaced the same time.

After the replacement of IC, SELF CHECK should be done to generate the final KEY data.

How to SELF CHECK: While pressing [VOLUME (-)] button on the main unit, press [MENU] button on the remote control for more than 3 seconds.

TV will be forced to the factory shipment setting after this SELF CHECK.

6 Service Mode

6.1. How to enter into Service Mode

6.1.1. Purpose

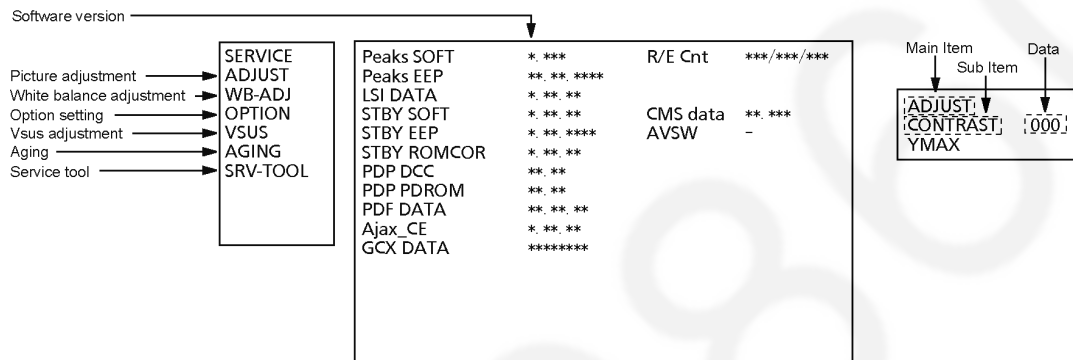
After exchange parts, check and adjust the contents of adjustment mode.

While pressing [VOLUME (-)] button of the main unit, press [INFO] button of the remote control three times within 2 seconds

Note:

Service Mode can not be entered when 3D signal input.

Input 2D signal to enter Service Mode.



6.1.2. Key command

[1] button...Main items Selection in forward direction

[2] button...Main items Selection in reverse direction

[3] button...Sub items Selection in forward direction

[4] button...Sub items Selection in reverse direction

[VOL] button...Value of sub items change in forward direction (+), in reverse direction (-)

6.1.3. How to exit

Switch off the power with the [POWER] button on the main unit or the [POWER] button on the remote control.

6.1.4. Contents of adjustment mode

- Value is shown as a hexadecimal number.
- Preset value differs depending on models.
- After entering the adjustment mode, take note of the value in each item before starting adjustment.

Main item	Sub item	Sample Data	Remark
ADJUST	CONTRAST	000	
	COLOR	3C	
	TINT	00	
	SUB-BRT	800	
WB-ADJ	R-CUT	80	
	G-CUT	80	
	B-CUT	80	
	R-DRV	FF	
	G-DRV	FF	
	B-DRV	B8	
	ALL-CUT	80	
	ALL-DRV	FF	
OPTION	Boot	ROM	Factory Preset
	STBY-SET	00	
	EMERGENCY	ON	
	CLK MODE	00	
	CLOCK	000	
	EDID-CLK	HIGH	
	MIRROR	00 (See Option-Mirror)	
VSUS		LOW	See Vsus selection
AGING	ALL WHITE		Built-in test patterns can be displayed.
	MIDDLE BLUE WITH MAGENTA OUTSIDE FRAME		
	MIDDLE STEP GREEN		
	MIDDLE STEP RED		
	LOW STEP WHITE		
	ALL BLUE		
	ALL GREEN		
	ALL RED		
	WHITE DIAGONAL STRIPE		
	RED DIAGONAL STRIPE		
	GREEN DIAGONAL STRIPE		
	BLUE DIAGONAL STRIPE		
	A-ZONE & B-ZONE		
	1% WINDOW		
	COLOR BAR		
	9 POINTS BRIGHT MEASURE		
	2 DOT OUTSIDE FRAME		
	DOUBLE FIXED 1% WINDOW		
	VERTICAL LINE SCROLL		
	ON/OFF		
	R/G/B/W ROTATION WITH COUNT DISPLAY		
	HALF FIXED ALL WHITE		
	ALL WHITE WITH COUNT DISPLAY		
SRV-TOOL		00	See Service tool mode

6.2. Option - Mirror

Picture can be reversed left and right or up and down.

00 : Default (Normal picture is displayed)

01 : Picture is reversed left and right.

02 : Picture is reversed up and down.

00



01



02



Hint : If the defective symptom (e.g. Vertical bar or Horizontal bar) is moved by selection of this mirror, the possible cause is in A-board.

6.3. Service tool mode

6.3.1. How to access

1. Select [SRV-TOOL] in Service Mode.
2. Press [OK] button on the remote control.

SRV-TOOL	
Display of Flash ROM maker code →	Flash ROM : 2C - DC
Display of SOS History →	PTCT : 00 . 00 . 00 . 00 . 00 .
	Time 00000:40 Count 0000001

POWER ON TIME/COUNT
Press [MUTE] button (3 sec)

6.3.2. Display of SOS History

SOS History (Number of LED blinking) indication.

From left side; Last SOS, before Last, three occurrence before, 2nd occurrence after shipment, 1st occurrence after shipment.

This indication except 2nd and 1st occurrence after shipment will be cleared by [Self-check indication and forced to factory shipment setting].

6.3.3. POWER ON TIME/COUNT

Note : To display TIME/COUNT menu, highlight position, then press MUTE for 3 sec.

Time : Cumulative power on time, indicated hour : minute by decimal

Count : Number of ON times by decimal

Note : This indication will not be cleared by either of the self-checks or any other command.

6.3.4. Exit

Disconnect the AC cord from wall outlet or press the [POWER] button on the main unit for 3 seconds to turn off and then turn on automatically.

6.4. Hotel mode

1. Purpose

Restrict a function for hotels.

2. Access command to the Hotel mode setup menu

In order to display the Hotel mode setup menu:

While pressing [VOLUME (-)] button of the main unit, press [INPUT] button of the remote control three times within 2 seconds.

Then, the Hotel mode setup menu is displayed.

Hotel Mode	
Mode	Off
Input	—
Channel	—
Volume	25
Vol. Max	100
OSD Ctrl	Off
FP Ctrl	Off
Pow Ctrl	Off

3. To exit the Hotel mode setup menu

Switch off the power with the [POWER] button on the main unit or the [POWER] button on the remote control.

4. Explain the Hotel mode setup menu

Item	Function
Mode	Select hotel mode On/Off
Input	Select input signal modes. Set the input, when each time power is switched on. Selection: -, RF, HDMI1, HDMI2, HDMI3, AV • Off: give priority to a last memory.
Channel	Select channel when input signal is RF. Set the channel, each time power is switched on. Selection: Any channel number or [-]. [-] means the channel when turns off.
Volume	Adjust the volume when each time power is switched on. Range: 0 to 100
Vol. Max	Adjust maximum volume. Range: 0 to 100
OSD Ctrl	Restrict the OSD. Selection: Off/Pattern1 • Off: No restriction • Pattern1: restriction
FP Ctrl	Select front key conditions. Selection: Off/Pattern1/All • Off: altogether valid. • Pattern1: only input key is valid. • All: altogether invalid.
Pow Ctrl	Select POWER-On/Off condition when AC power cord is disconnected and then connected. Off: The same condition when AC power cord is disconnected. On: Forced power ON condition.

6.5. Data Copy by USB Memory

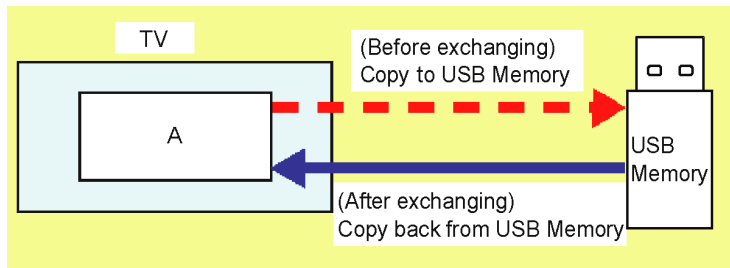
Note:

SD card can not be used for Data Copy.

6.5.1. Purpose

(a) Board replacement (Copy the data when exchanging A-board):

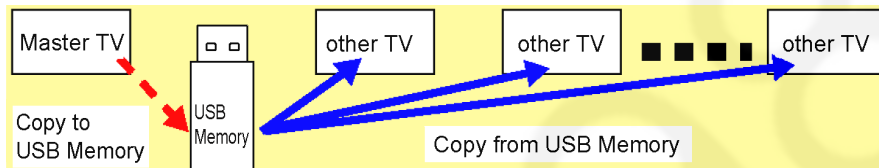
When exchanging A-board, the data in original A-board can be copied to USB Memory and then copy to new A-board.



Following data can be copied.
User setting data
(incl. Hotel mode setting data)
Channel scan data
Adjustment and factory preset data

(b) Hotel (Copy the data when installing a number of units in hotel or any facility):

When installing a number of units in hotel or any facility, the data in master TV can be copied to USB Memory and then copy to other TVs.



Following data can be copied.
User setting data
(incl. Hotel mode setting data)
Channel scan data

6.5.2. Preparation

Make pwd file as startup file for (a) or (b) in a empty USB Memory.

1. Insert a empty USB Memory to your PC.
2. Right-click a blank area in a USB Memory window, point to New, and then click text document. A new file is created by default (New Text Document.txt).
3. Right-click the new text document that you just created and select rename, and then change the name and extension of the file to the following file name for (a) or (b) and press ENTER.

File name:

(a) For Board replacement : boardreplace.pwd

(b) For Hotel : hotel.pwd

Note:

Please make only one file to prevent the operation error.

No any other file should not be in USB Memory.

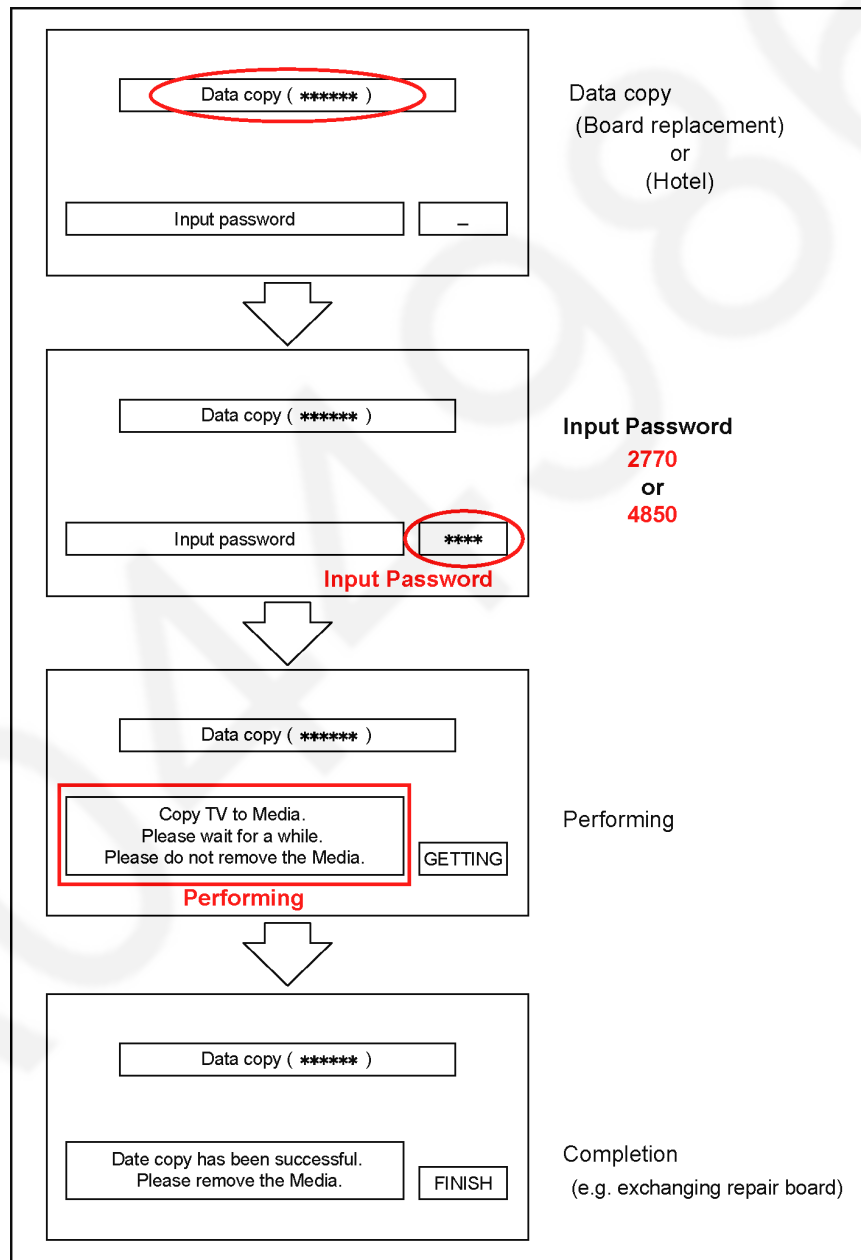
6.5.3. Data copy from TV set to USB Memory

1. Turn on the TV set.
2. Insert USB Memory with a startup file (pwd file) to USB terminal.
On-screen Display will be appeared according to the startup file automatically.
3. Input a following password for (a) or (b) by using remote control.
(a) For Board replacement : 2770
(b) For Hotel : 4850
Data will be copied from TV set to USB Memory.
It takes around 2 to 6 minutes maximum for copying.
4. After the completion of copying to USB Memory, remove USB Memory from TV set.
5. Turn off the TV set.

Note:

Following new folder will be created in USB Memory for data from TV set.

- (a) For Board replacement : user_setup
- (b) For Hotel : hotel

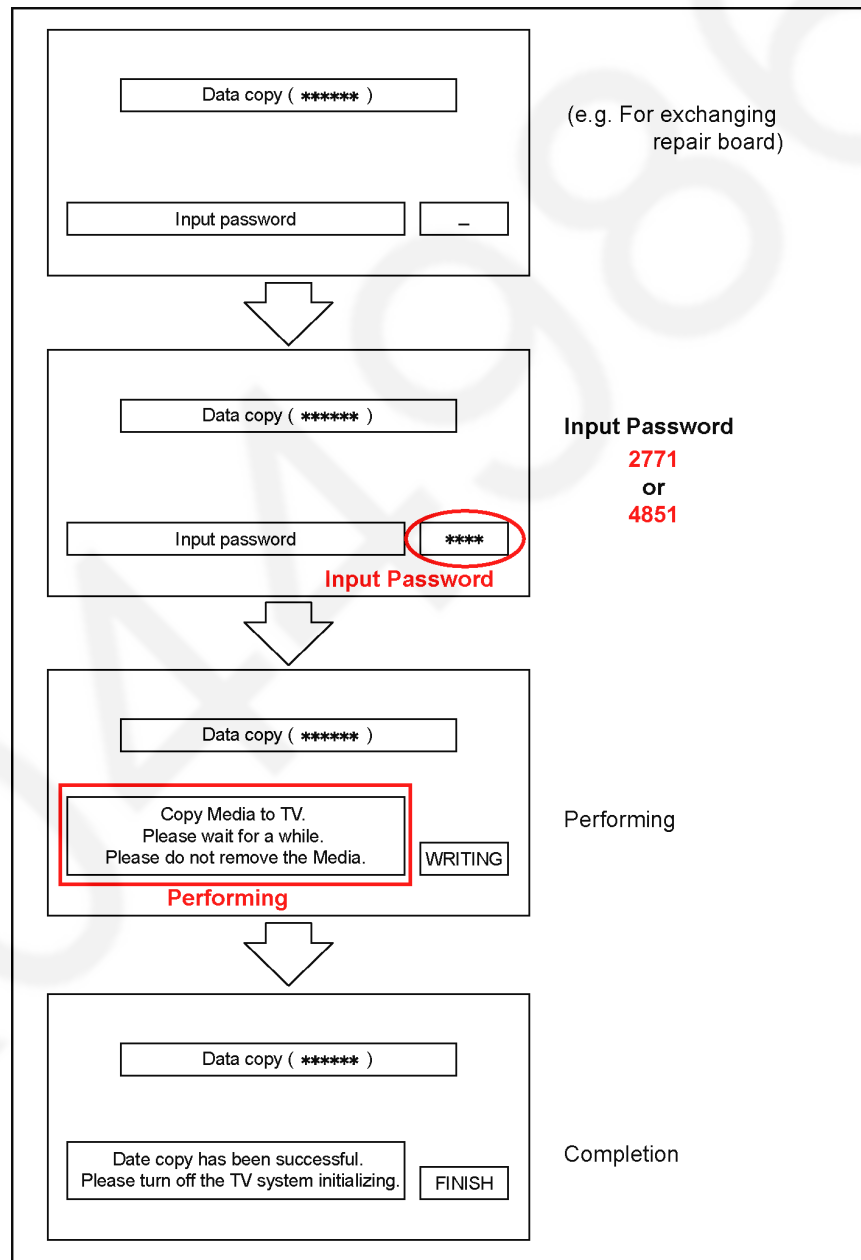


6.5.4. Data copy from USB Memory to TV set

1. Turn on the TV set.
2. Insert USB Memory with Data to USB terminal.
On-screen Display will be appeared according to the Data folder automatically.
3. Input a following password for (a) or (b) by using remote control.
(a) For Board replacement : 2771
(b) For Hotel : 4851
Data will be copied from USB Memory to TV set.
4. After the completion of copying to USB Memory, remove USB Memory from TV set.
(a) For Board replacement : Data will be deleted after copying (Limited one copy).
(b) For Hotel : Data will not be deleted and can be used for other TVs.
5. Turn off the TV set.

Note:

1. Depending on the failure of boards, function of Data copy for board replacement does not work.
2. This function can be effective among the same model numbers.



7 Troubleshooting Guide

For detailed troubleshooting information and circuit explanations, refer to the "QSM/Service Hints/Troubleshooting Information(TI)" and Seminar/Training Manual/Technical Guide(TG) documents posted on the TSN web site.

For information about this model, type TC-P2013 in the model box under "Direct Search".

8 Service Fixture & Tools

8.1. SC jig

Purpose:

To find the failure board (SC or SU/SD) when the power LED is blinking 7 times.

SC jig:

Jumper connector to connect to SC50 connector on SC board

Part number:

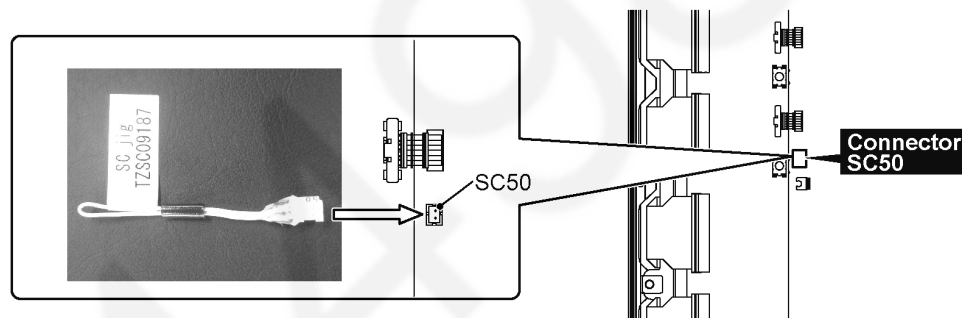
TZSC09187

How to use:

Caution: Remove SC jig from SC board after inspection.

1. Remove the 2 VFG screws from SU and SD board.
2. Remove all connector between SC board and SU/SD board to isolate SC board from both SU and SD board electrically.
Note: The board will be damaged if all connector is not removed (for example; remove connector only for SU board and stay connecting with SD board. The board will be damaged.)
3. Connect SC jig to connector SC50 at left bottom side of SC board
4. Turn on the TV/Display Unit and confirm the power LED blinking.
LED blinking: Possible cause of failure is in SC board
No LED blinking (Lighting or no lighting): Possible cause of failure is in SU or SD board
5. After inspection, turn off the TV/Display Unit and wait a few minutes to discharge.
6. Remove SC jig from SC board.

Remark: This SC jig can be used for all 2013 Plasma TV and Plasma Display.

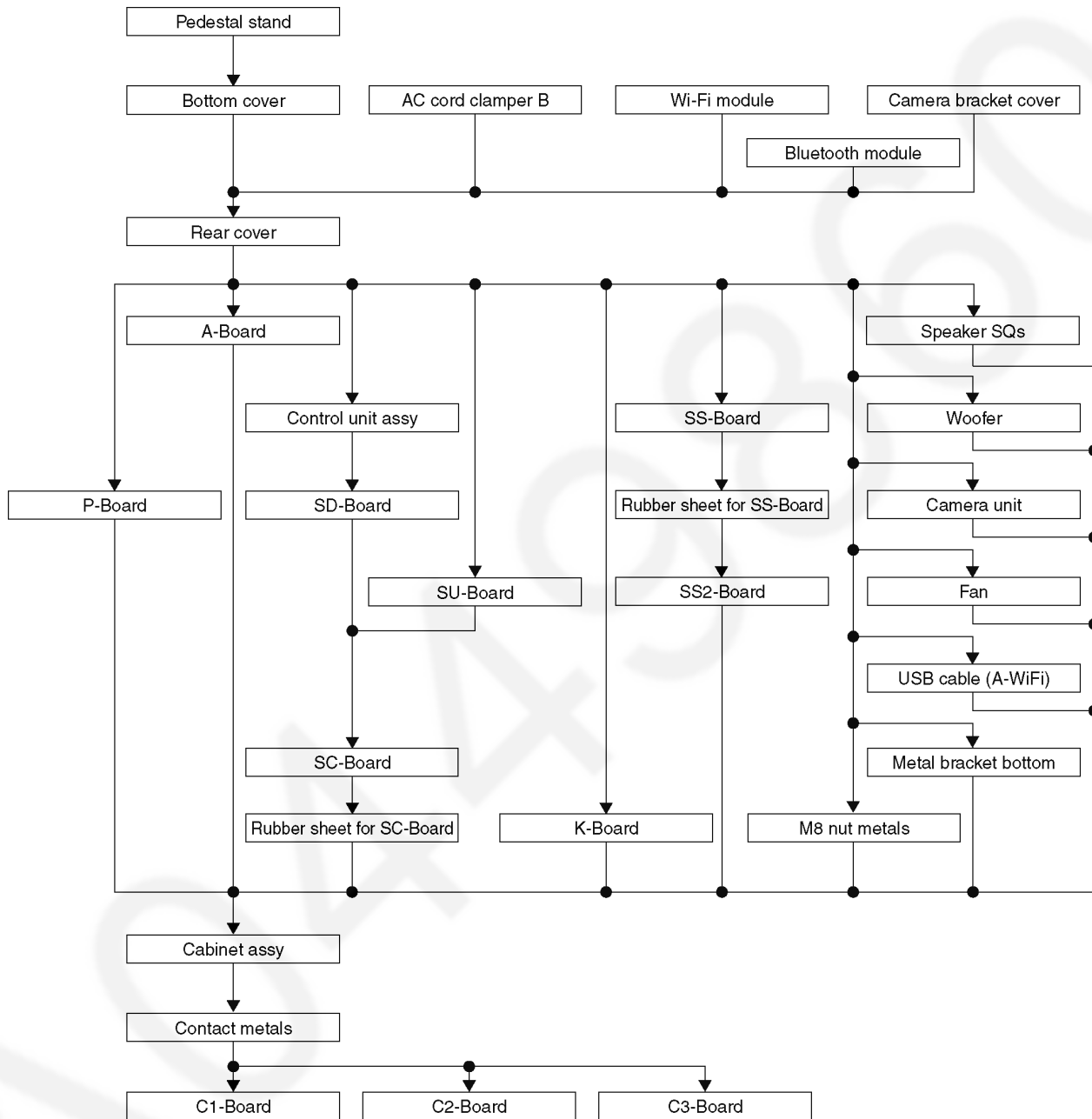


9 Disassembly and Assembly Instructions

9.1. Disassembly Flow Chart for the Unit

This is a disassembly chart.

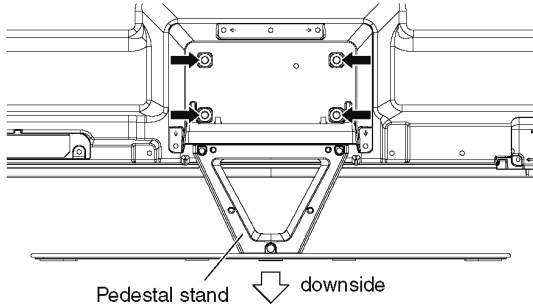
When assembling, perform this chart conversely.



9.2. Disassembly Procedure for the Unit

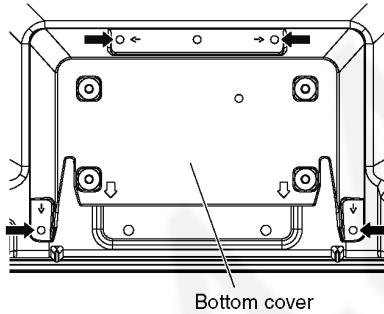
9.2.1. Remove the Pedestal stand

1. Remove the Plasma panel section from the servicing stand and lay on a flat surface such as a table (covered by a soft cloth) with the Plasma panel surface facing downward.
2. Remove the screws (×4 ➡) and
3. Slide the Pedestal stand to the downside and remove the Pedestal stand.



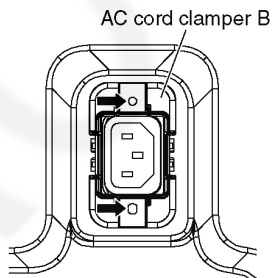
9.2.2. Remove the Bottom cover

1. Remove the screws (×4 ➡) and remove the Bottom cover.



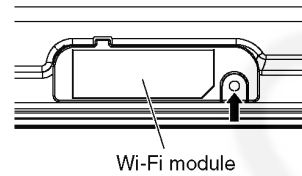
9.2.3. Remove the AC cord clamber B

1. Remove the screws (×2 ➡) and remove the AC cord clamber B.



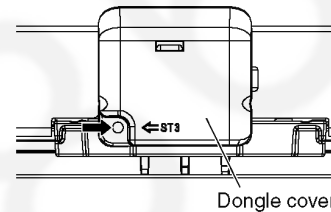
9.2.4. Remove the Wi-Fi module

1. Remove the screw (×1 ➡) and remove the Wi-Fi module.

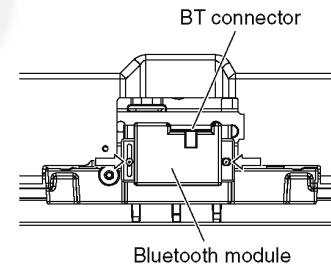


9.2.5. Remove the Bluetooth module

1. Remove the screw (×1 ➡) and remove the Dongle cover.

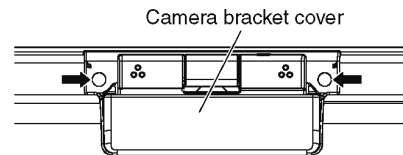


2. Remove the Pin guides (×2 ⇔) and disconnect the BT connector.
3. Remove the Bluetooth module.



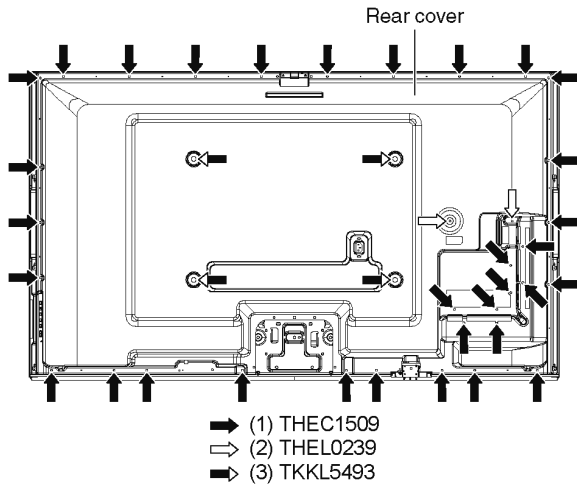
9.2.6. Remove the Camera bracket cover

1. Remove the screws (×2 ➡) and remove the Camera bracket cover.



9.2.7. Remove the Rear cover

1. Remove the screws (×33 ➡, ×2 ⇨).
2. Remove the M8 caps (×4 ➡).
3. Remove the Rear cover.

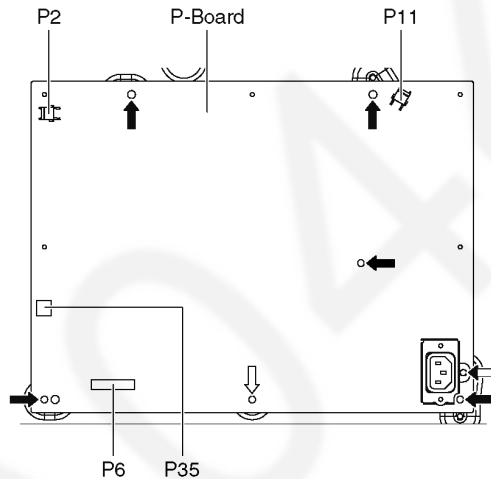


9.2.8. Remove the P-Board

Caution:

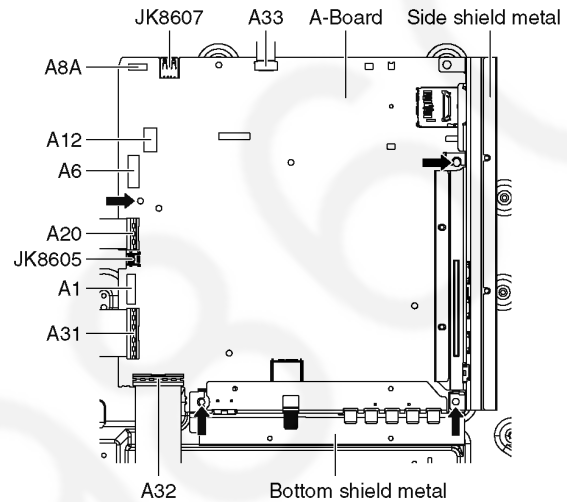
To remove P.C.B. wait 1 minute after power was off for discharge from electrolysis capacitors.

1. Unlock the hooks and the tapes to free the cables
2. Disconnect the connectors (P2, P6, P11 and P35).
3. Remove the screws (×5 ➡, ×1 ⇨, ×1 ⇨) and remove the P-Board.

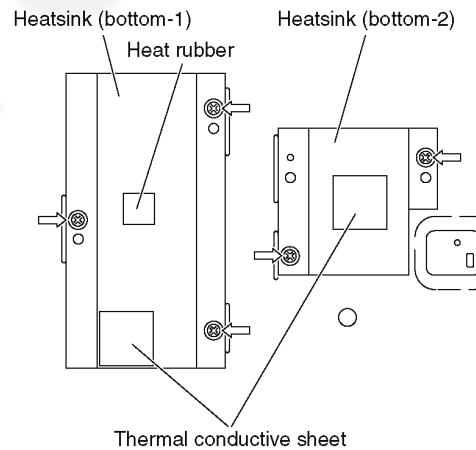


9.2.9. Remove the A-Board

1. Unlock the hooks and the tapes to free the cables.
2. Disconnect the connectors (A1, A6, A8A and A12).
3. Disconnect the USB cables (JK8605 and JK8607).
4. Disconnect the flexible cables (A20, A31, A32 and A33).
5. Remove the screws (×4 ➡).
6. Remove the Side shield metal and the Bottom shield metal.
7. Remove the A-Board.

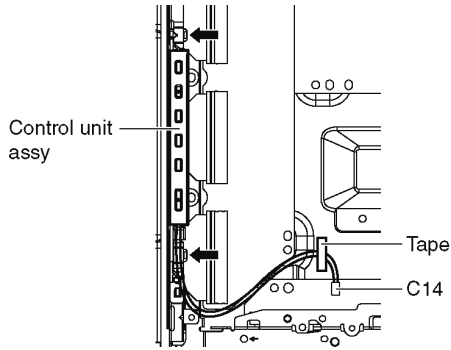


8. Remove the screws (×5 ⇨).
9. Remove the Heatsinks (bottom-1, -2), the Thermal conductive sheets and the Heat rubber.



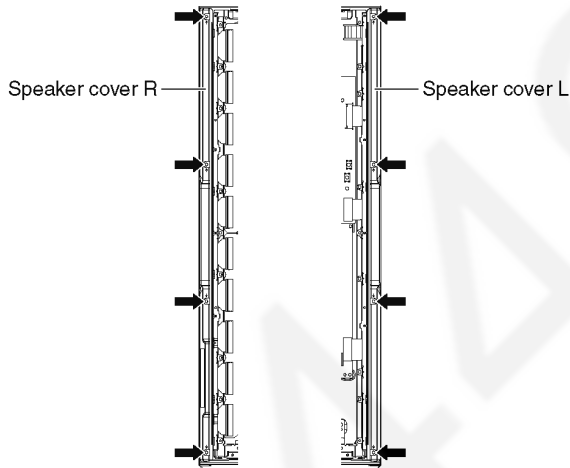
9.2.10. Remove the Control unit assy

1. Unlock the tape to free the cables.
2. Disconnect the connector (C14).
3. Remove the claws (×2 ➡) and remove the Control unit assy.

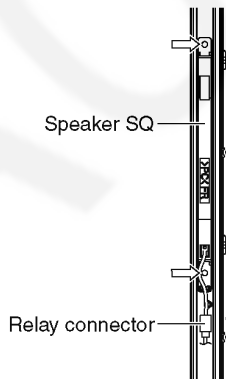


9.2.11. Remove the Speaker SQs

1. Unlock the hooks and the tapes to free the cables.
2. Remove the screws (×4 ➡ each) and remove the Speaker covers (L, R).

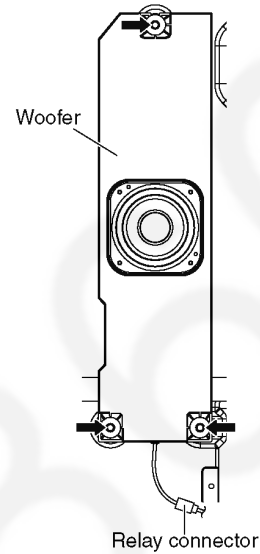


3. Disconnect the Relay connector.
4. Remove the screws (×2 ⇨ each) and remove the Speaker SQs (L, R).



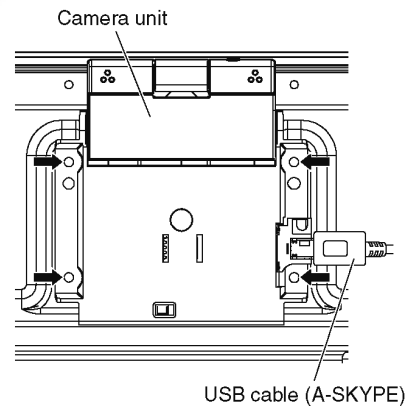
9.2.12. Remove the Woofer

1. Unlock the hooks and the tapes to free the cables.
2. Disconnect the Relay connector.
3. Remove the screws (×3 ➡) and remove the Woofer.



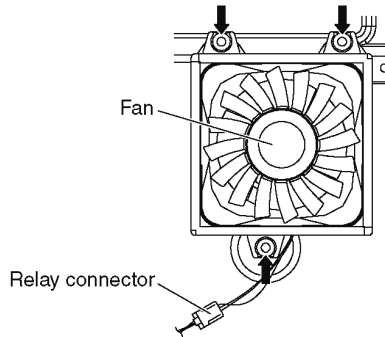
9.2.13. Remove the Camera unit

1. Unlock the hooks and the tapes to free the cables.
2. Disconnect the USB cable (A-SKYPE).
3. Remove the screws (×4 ➡) and remove the Camera unit.



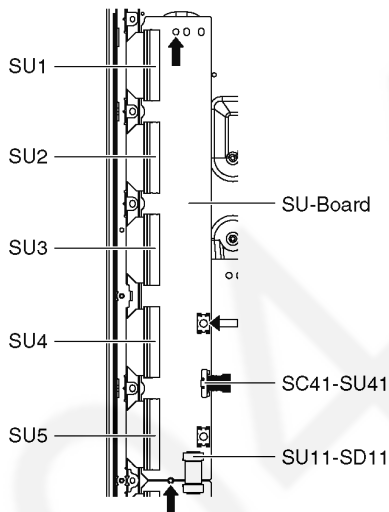
9.2.14. Remove the Fan

1. Unlock the hooks and the tapes to free the cables.
2. Remove the screws (×3 ➡ each).
3. Disconnect the Relay connector and remove the Fans.



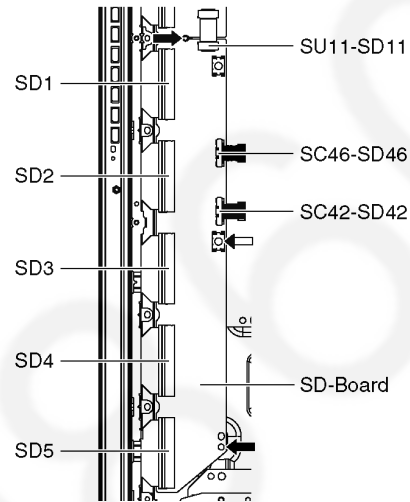
9.2.15. Remove the SU-Board

1. Disconnect the flexible cables (SU1, SU2, SU3, SU4 and SU5) connected to the SU-Board.
2. Disconnect the flexible cable (SU11-SD11) and the bridge connector (SC41-SU41).
3. Remove the screws (×2 ➡, ×1 ⇨) and remove the SU-Board.



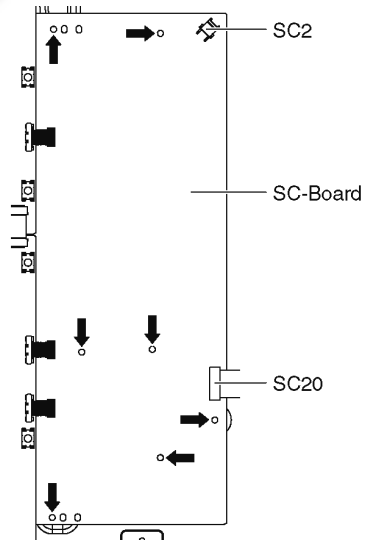
9.2.16. Remove the SD-Board

1. Disconnect the flexible cables (SD1, SD2, SD3, SD4 and SD5) connected to the SD-Board.
2. Disconnect the flexible cable (SU11-SD11) and the bridge connectors (SC42-SD42 and SC46-SD46).
3. Remove the screws (×2 ➡, ×1 ⇨) and remove the SD-Board.



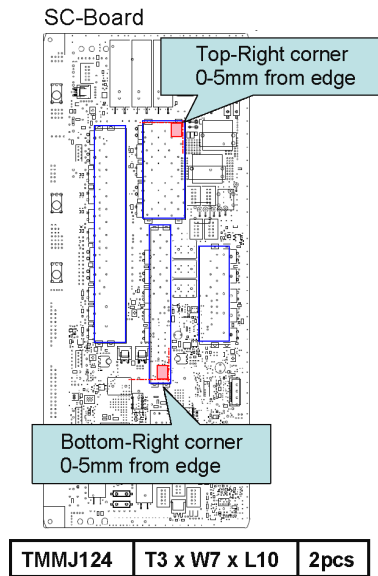
9.2.17. Remove the SC-Board

1. Unlock the tapes to free the cables.
2. Disconnect the connector (SC2).
3. Disconnect the flexible cable (SC20).
4. Remove the screws (×7 ➡) and remove the SC-Board.



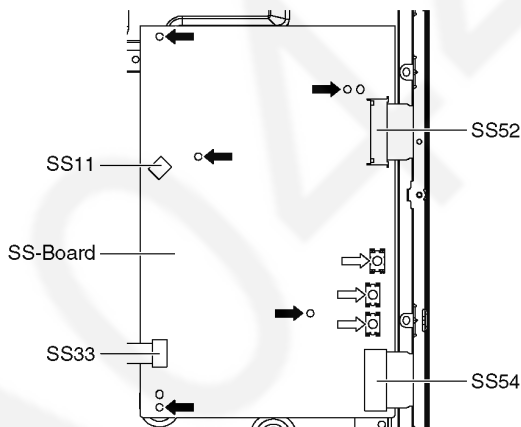
9.2.18. Work instructions for the Rubber sheet for SC-Board

1. Rubber sheets are put between the board and rear cover for EMC requirement and heat radiation. Confirm rubber sheets were placed at each portion when assembling as shown in figure.



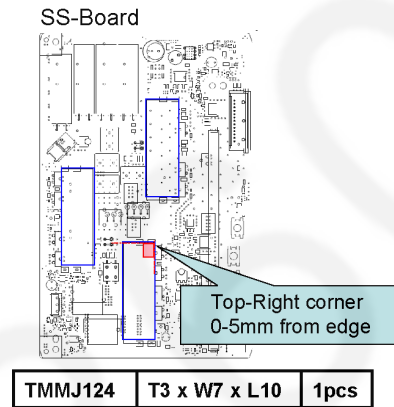
9.2.19. Remove the SS-Board

1. Disconnect the connector (SS11).
2. Disconnect the flexible cable (SS33).
3. Disconnect the flexible cables (SS52 and SS54).
4. Remove the screws (×5 ➡, ×3 ⇨) and remove the SS-Board.



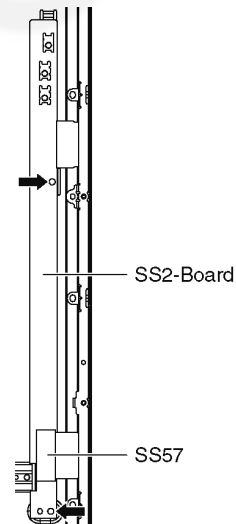
9.2.20. Work instructions for the Rubber sheet for SS-Board

1. Rubber sheets are put between the board and rear cover for EMC requirement and heat radiation. Confirm rubber sheets were placed at each portion when assembling as shown in figure.



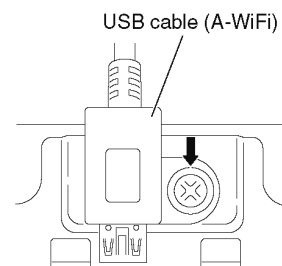
9.2.21. Remove the SS2-Board

1. Disconnect the flexible cable (SS57).
2. Remove the screws (×2 ➡) and remove the SS2-Board.



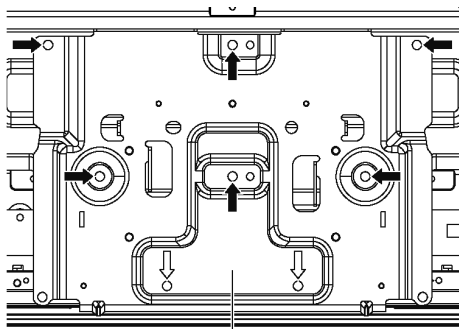
9.2.22. Remove the USB cable (A-WiFi)

1. Remove the screw (×1 ➡).
2. Remove the USB cable (A-WiFi).



9.2.23. Remove the Metal bracket bottom

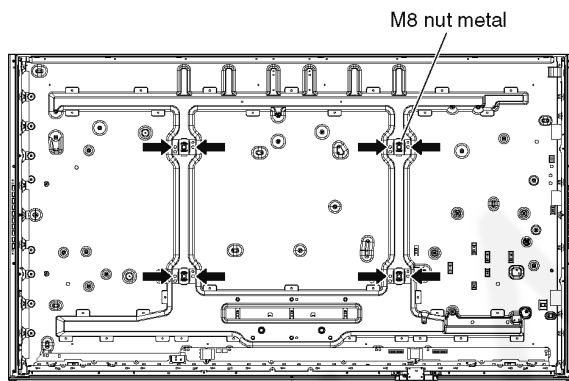
1. Remove the screws (×6 ➡, ×2 ⇨) and the Metal bracket bottom.



Metal bracket Bottom

9.2.24. Remove the M8 nut metals

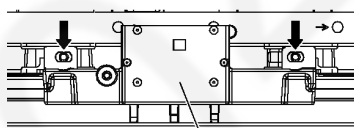
1. Remove the screws (×2 ➡ each) and remove the M8 nut metals.



M8 nut metal

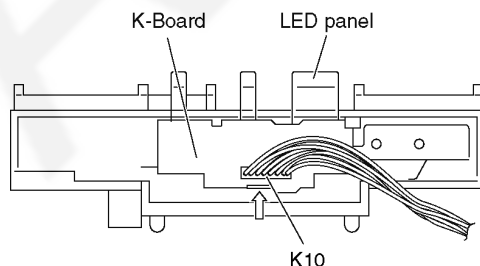
9.2.25. Remove the K-Board

1. Remove the screws (×2 ➡) and remove the LED panel case.



LED panel case

2. Disconnect the connector (K10).
3. Remove the claw (×1 ⇨) and remove the K-Board.
4. Remove the LED panel.



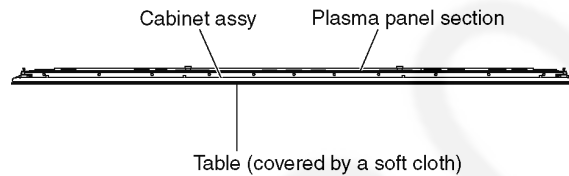
K-Board

LED panel

K10

9.2.26. Remove the Cabinet assy from the Plasma panel section

1. Remove the Plasma panel section from the servicing stand and lay on a flat surface such as a table (covered by a soft cloth) with the Plasma panel surface facing downward.

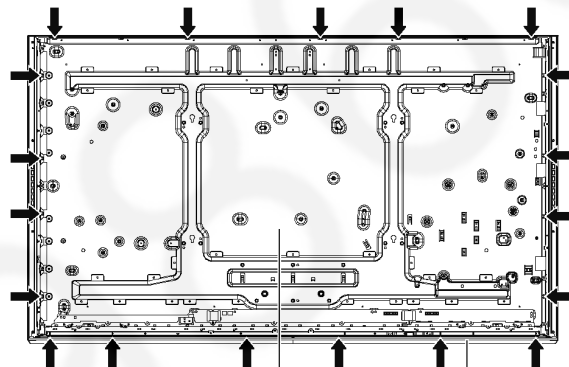


Cabinet assy

Plasma panel section

Table (covered by a soft cloth)

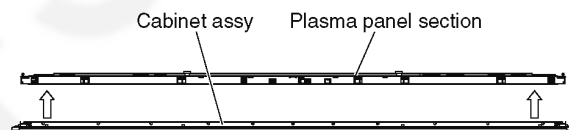
2. Remove the screws (×19 ➡).



Plasma panel section

Cabinet assy

3. Remove the Cabinet assy from the Plasma panel section.



Cabinet assy

Plasma panel section

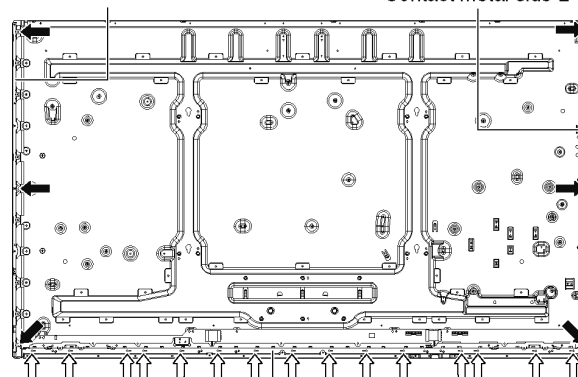
Table (covered by a soft cloth)

9.2.27. Remove the Contact metals

1. Remove the screws (×6 ➡).
2. Remove the Contact metal side (L, R).
3. Remove the screws (×15 ⇨).
4. Remove the Contact metal bottom.

Contact metal side R

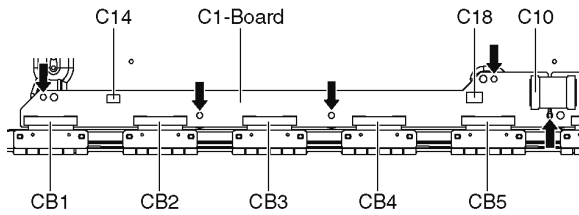
Contact metal side L



Contact metal bottom

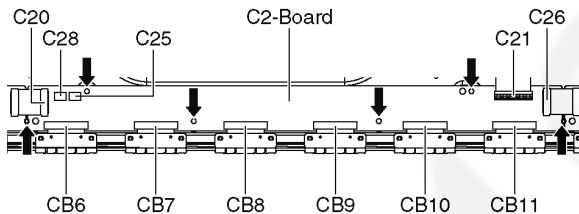
9.2.28. Remove the C1-Board

1. Disconnect the flexible cables (CB1, CB2, CB3, CB4 and CB5).
2. Disconnect the flexible cable (C10).
3. Disconnect the connectors (C14 and C18).
4. Remove the screws (×5 ➡) and remove the C1-Board.



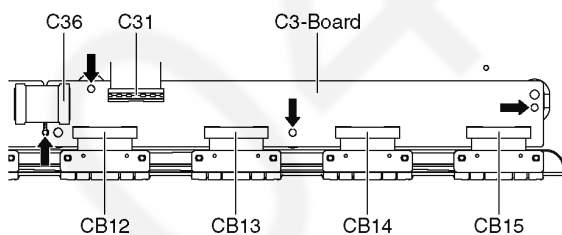
9.2.29. Remove the C2-Board

1. Disconnect the flexible cables (CB6, CB7, CB8, CB9, CB10 and CB11).
2. Disconnect the flexible cables (C20, C21 and C26).
3. Disconnect the connectors (C25 and C28).
4. Remove the screws (×6 ➡) and remove the C2-Board.



9.2.30. Remove the C3-Board

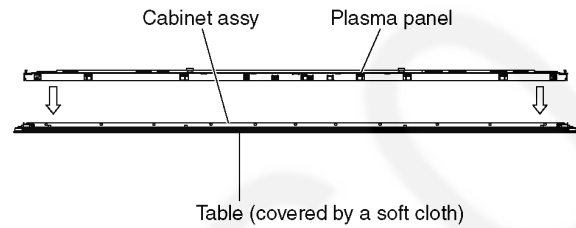
1. Disconnect the flexible cables (CB12, CB13, CB14 and CB15).
2. Disconnect the flexible cables (C31 and C36).
3. Remove the screws (×4 ➡) and remove the C3-Board.



9.2.31. Replace the Plasma panel

Caution:

Remove the Plasma panel section from the servicing stand and lay on a flat surface such as a table (covered by a soft cloth) with the Plasma panel surface facing downward.



A new Plasma panel itself without Contact metals is fragile. To avoid the damage to new Plasma panel, carry a new Plasma panel taking hold of the Contact metals.

1. Place a carton box packed a new Plasma panel on the flat surface of the work bench.
2. Open a box and without taking a new Plasma panel.
3. Attach the Cabinet assy and each P.C.Board and so on, to the new Plasma panel.

10 Measurements and Adjustments

10.1. Adjustment

10.1.1. Vsus selection

Caution:

When Plasma panel or A-board is replaced, Vsus should be set to LOW or HIGH.

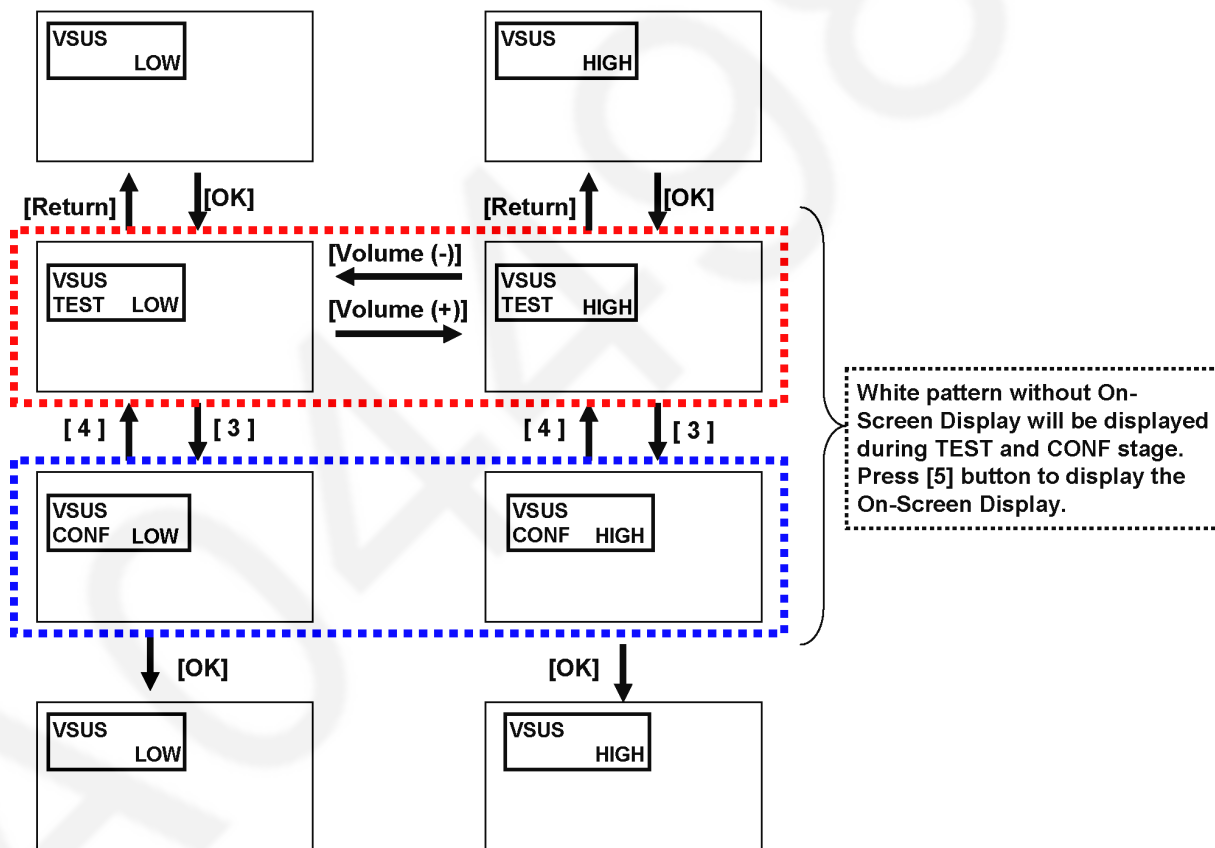
Procedure

1. Go into main item [VSUS] in Service Mode. LOW or HIGH will be displayed.
2. Press [OK] button to go to TEST stage.
White pattern without On-Screen Display will be displayed during TEST and CONF stage. Press [5] button to display the On-Screen Display.
3. Press [VOL (-)] button to set to LOW.
4. In LOW setting
 - a. If no several dead pixel is visible remarkably in white pattern, press [3] button to go to CONF stage.
 - b. If the several dead pixels are visible remarkably in white pattern, Set to HIGH by press [VOL (+)] button. Press [3] button to go to CONF stage if the symptom is improved.
5. Press [OK] button in CONF stage to store LOW or HIGH.
6. Exit Service Mode by pressing [Power] button.

Notes:

Do not overwrite because data is written in NAND Flash after executing adjustment of V-SUS Voltage.

Vsus selection in Service mode



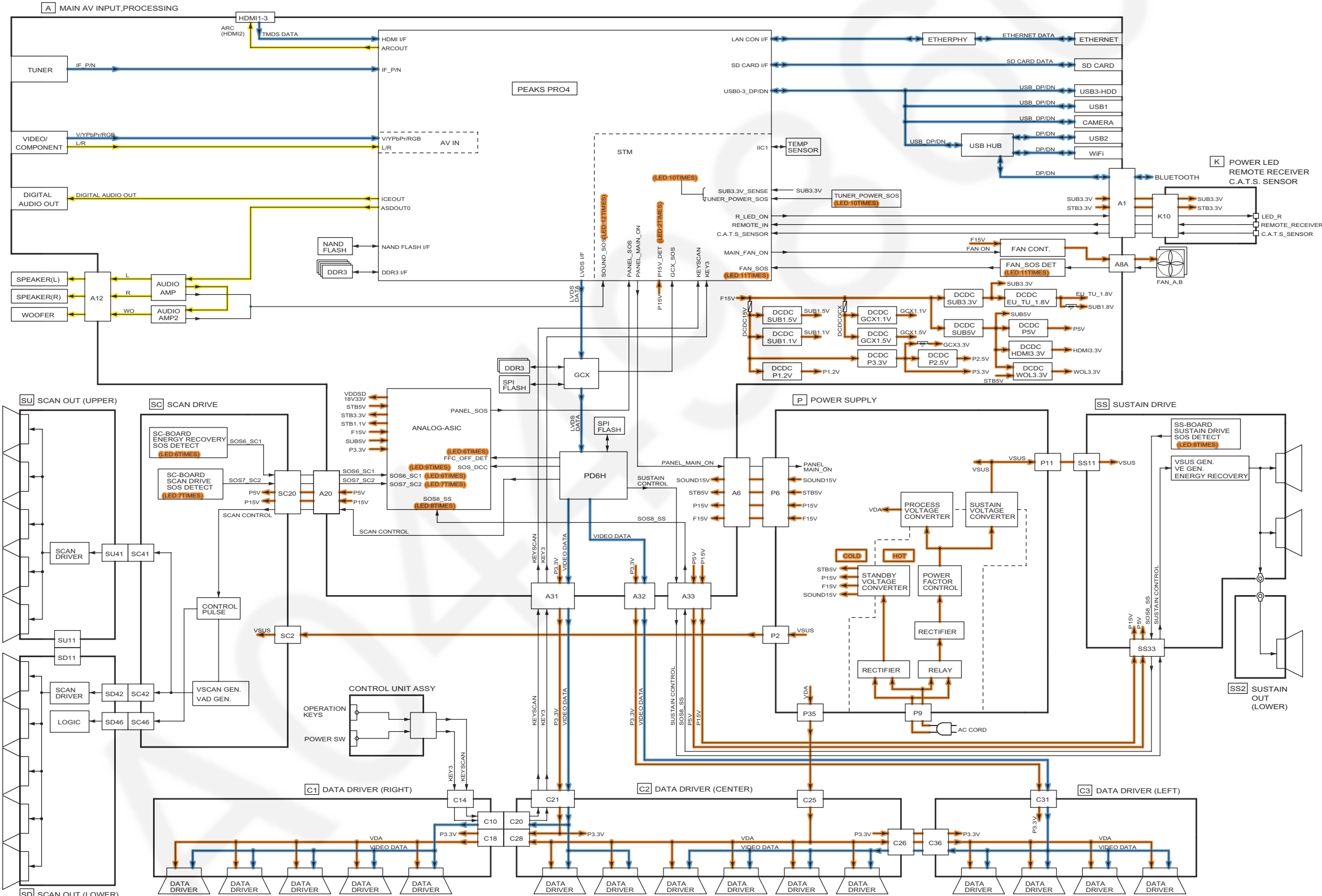
10.1.2. White balance adjustment

Name of measuring instrument	Remarks																				
Color analyzer (Minolta CS-1000 or equivalent)																					
Procedure	Remarks																				
<div>1. Enter the Service mode.</div> <div>2. Receive the Analog-RF (except for no signal) or set CVBS/YUV/HDMI (no signal is available).</div> <div>3. Select [WB-ADJ] by using [1] and [2] key in the remote controller.</div> <div>4. Check that the color temp and the picture mode is the values written in table1.</div> <div>5. [INNER PATTERN] is displayed by using [5] key by using [5] key in the remote controller.</div> <div>6. Select [G-CUTOFF] by using the [3] and [4] key in the remote controller, and set the value to [80] by using the volume [+] and [-] key. Also, [B-CUTOFF] and [R-CUTOFF] set to [80]</div> <div>7. Set [G-DRIVE] value to the initial data (ex. D0).</div> <div>8. Set the color analyzer and adjust color point to the values written in table1 by using [B-DRIVE] and [R-DRIVE]</div> <div>9. Increase RGB-DRIVE value so that the maximum drive value of one of R-DRIVE or G-DRIVE or B-DRIVE should become [FF] ([ALL-DRIVE] set to [FF].)</div> <div>Table 1 : White Balance Target value</div> <table><tr><th colspan="2">COOL</th><th colspan="2">NORMAL</th><th colspan="2">WARM</th><th rowspan="2">adjust at;</th></tr><tr><th>x</th><th>y</th><th>x</th><th>y</th><th>x</th><th>y</th></tr><tr><td>0.266 ±0.01</td><td>0.268 ±0.01</td><td>0.288 ±0.01</td><td>0.296 ±0.01</td><td>0.313 ±0.005</td><td>0.329 ±0.005</td><td>color temp: Warm picture mode:Cinema</td></tr></table>	COOL		NORMAL		WARM		adjust at;	x	y	x	y	x	y	0.266 ±0.01	0.268 ±0.01	0.288 ±0.01	0.296 ±0.01	0.313 ±0.005	0.329 ±0.005	color temp: Warm picture mode:Cinema	
COOL		NORMAL		WARM		adjust at;															
x	y	x	y	x	y																
0.266 ±0.01	0.268 ±0.01	0.288 ±0.01	0.296 ±0.01	0.313 ±0.005	0.329 ±0.005	color temp: Warm picture mode:Cinema															

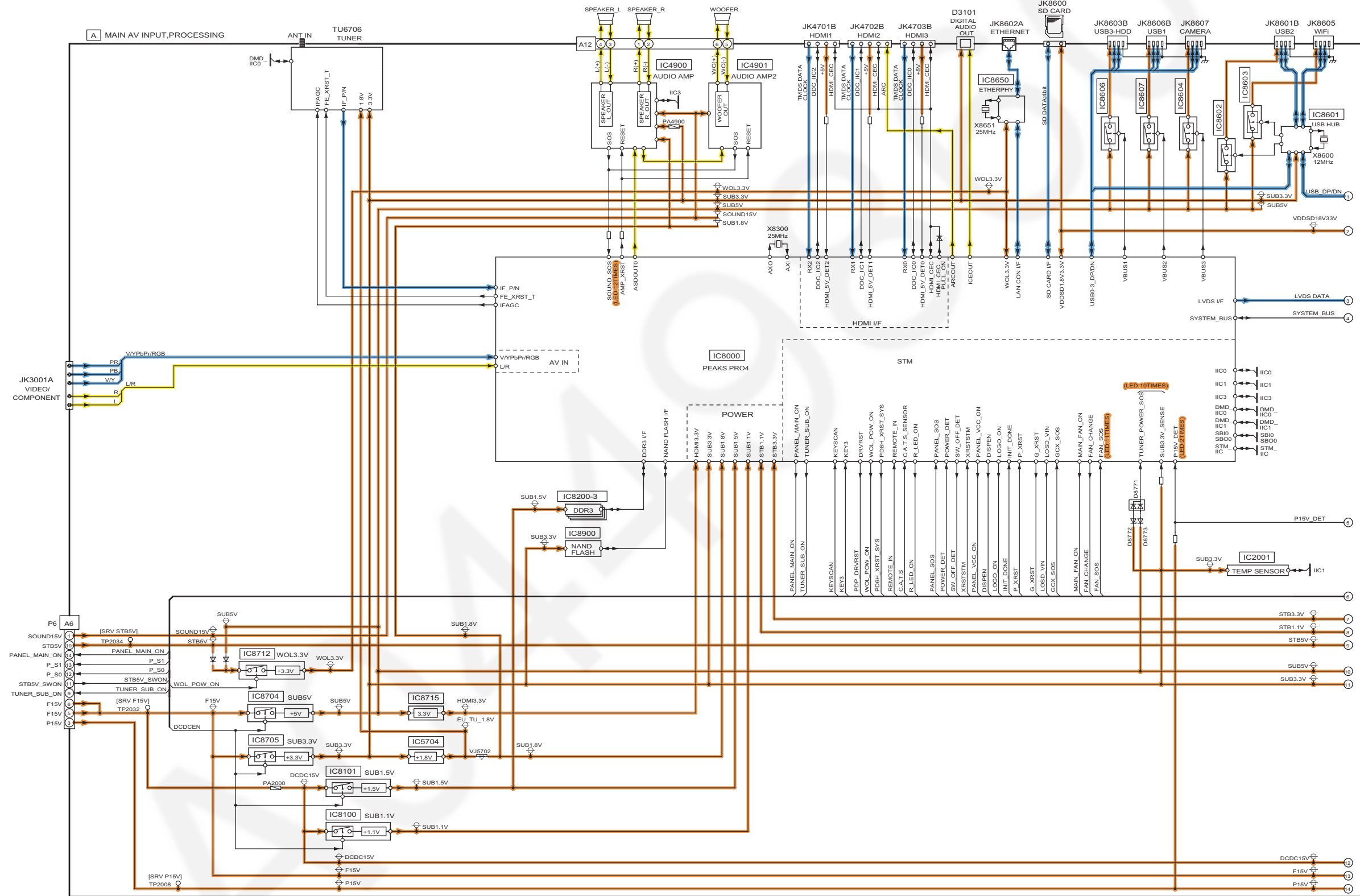
A0449860

11 Block Diagram

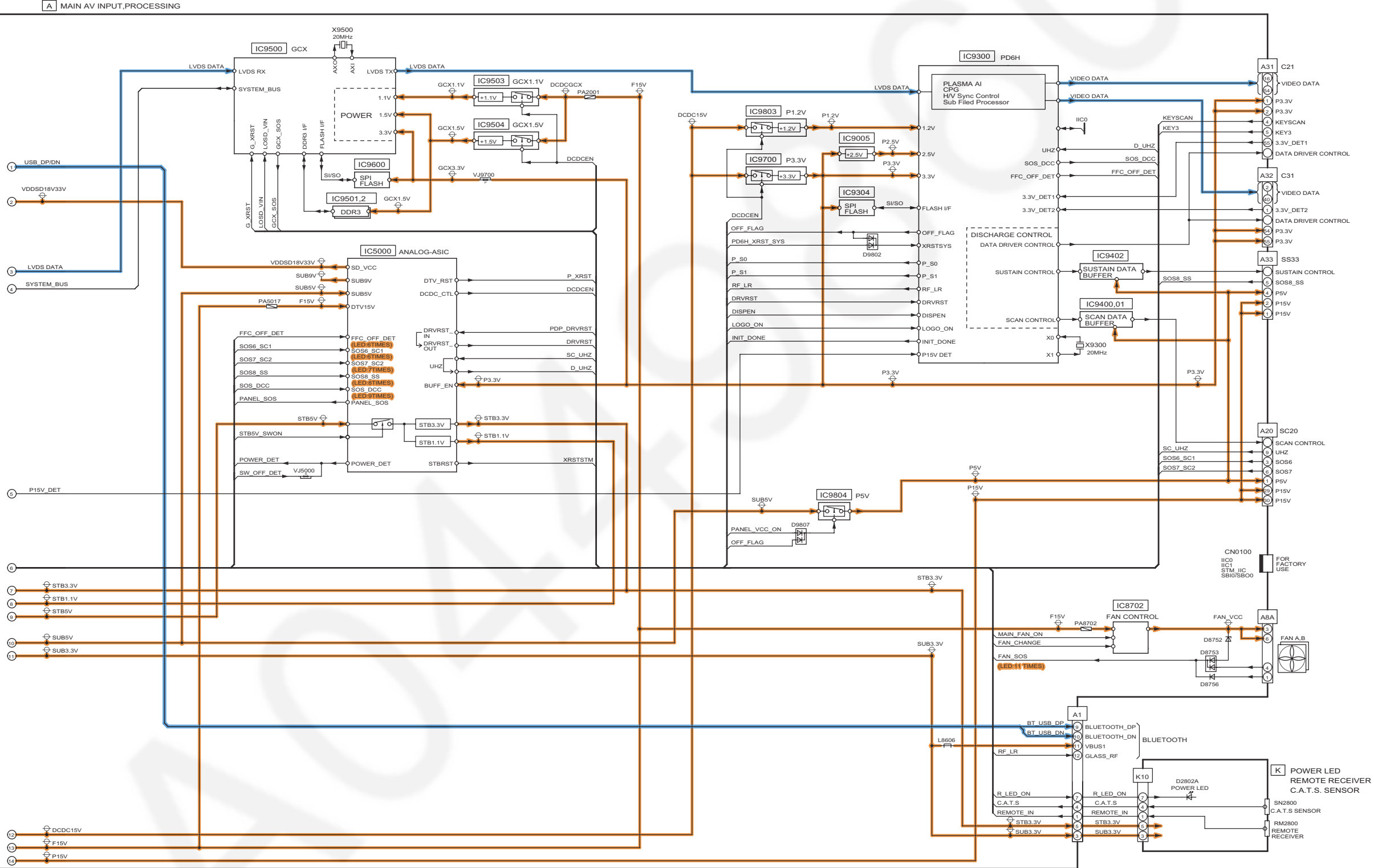
11.1. Main Block Diagram



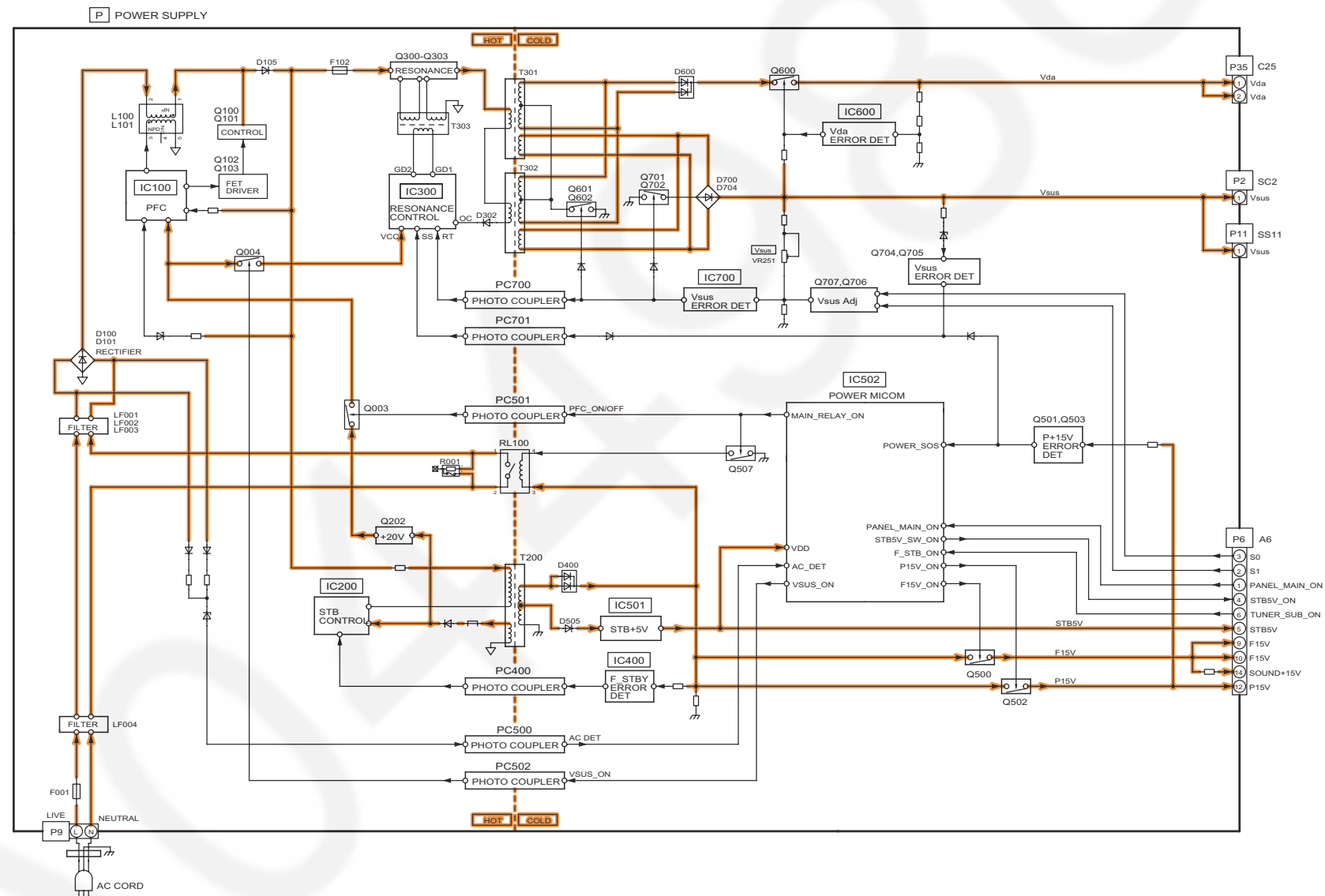
11.2. Block (1/4) Diagram



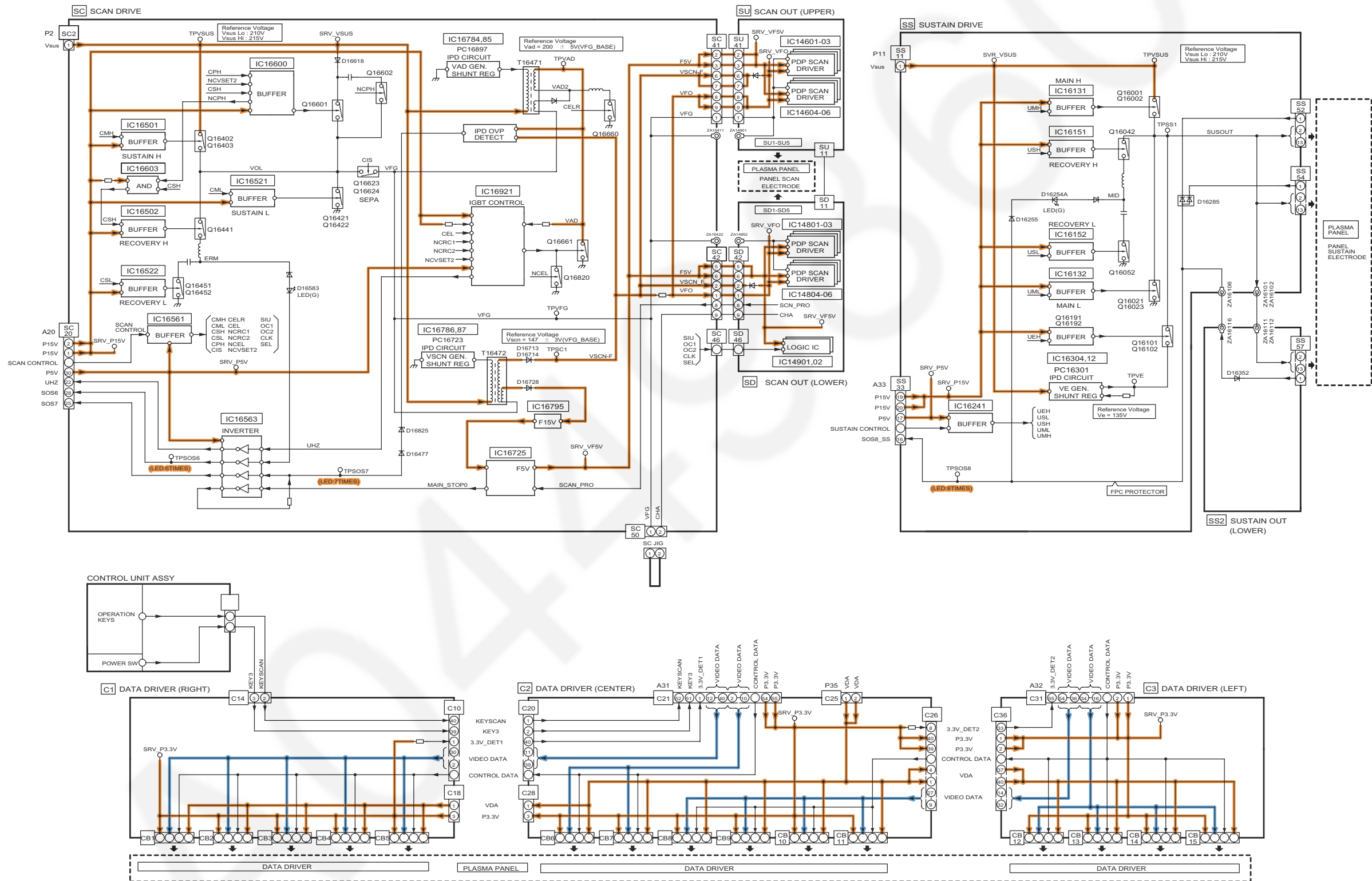
11.3. Block (2/4) Diagram



11.4. Block (3/4) Diagram



11.5. Block (4/4) Diagram



A0449860

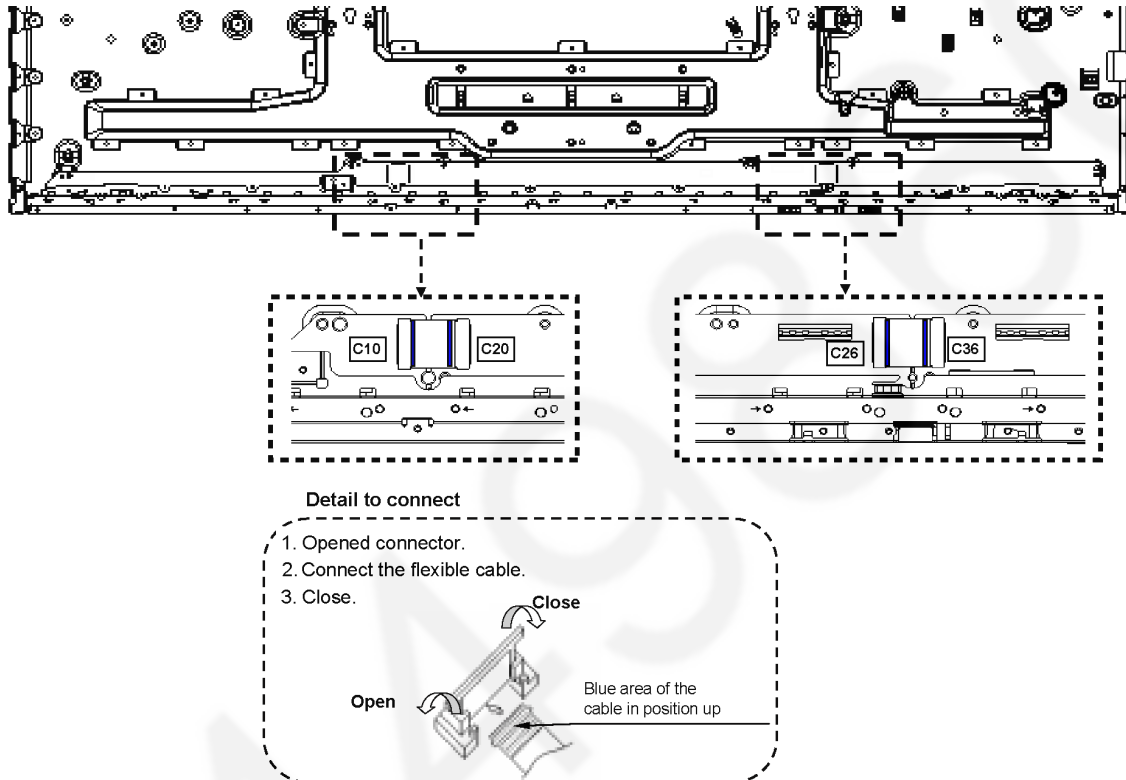
12 Wiring Connection Diagram

12.1. Caution statement.

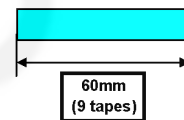
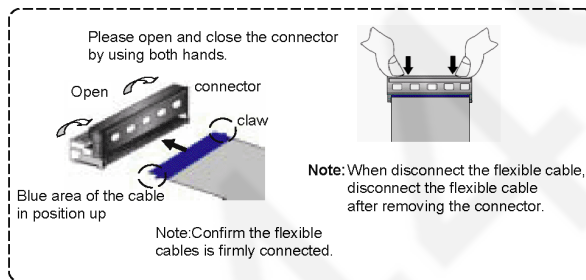
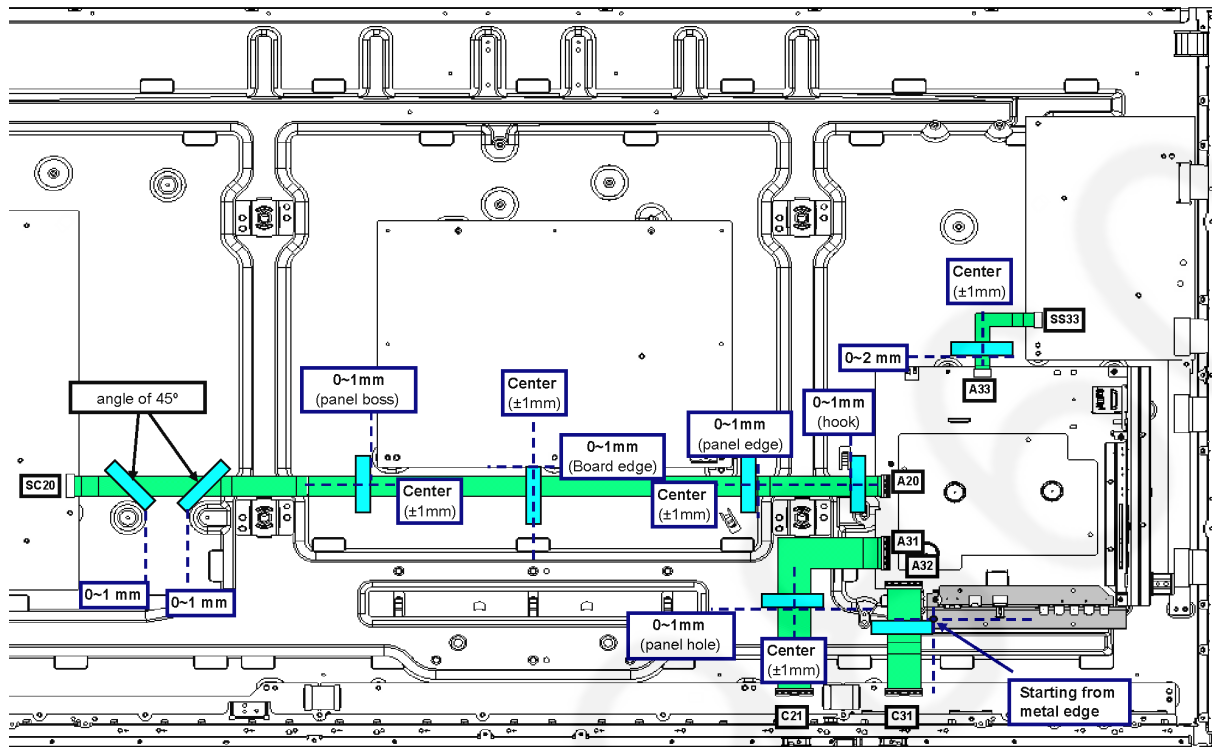
Caution:

Please confirm that all flexible cables are assembled correctly.
Also make sure that they are locked in the connectors.
Verify by giving the flexible cables a very slight pull.

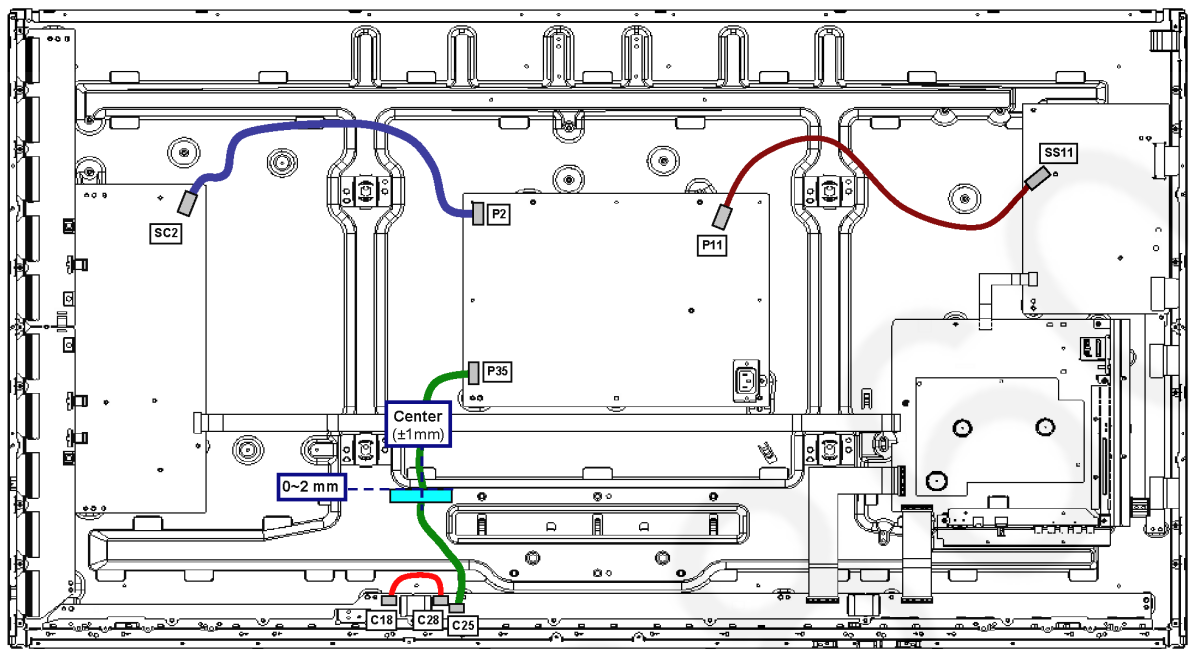
12.2. Wiring (1)



12.3. Wiring (2)



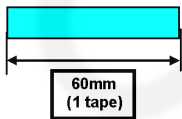
12.4. Wiring (3)



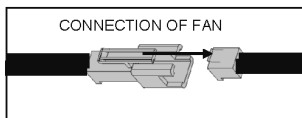
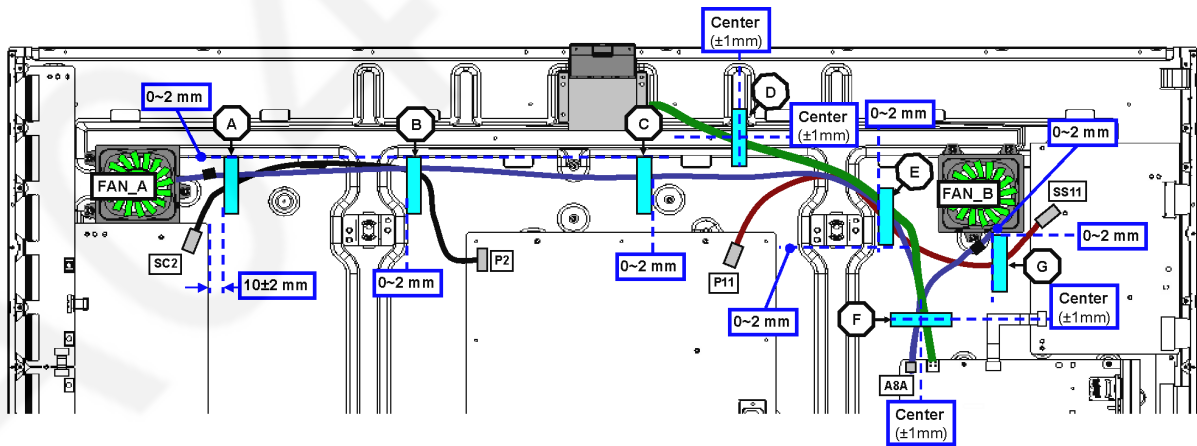
Note.
Install the cable correctly
please insert the connector straight.

INCORRECT **CORRECT**

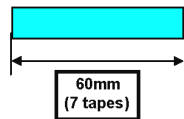
CONNECTOR



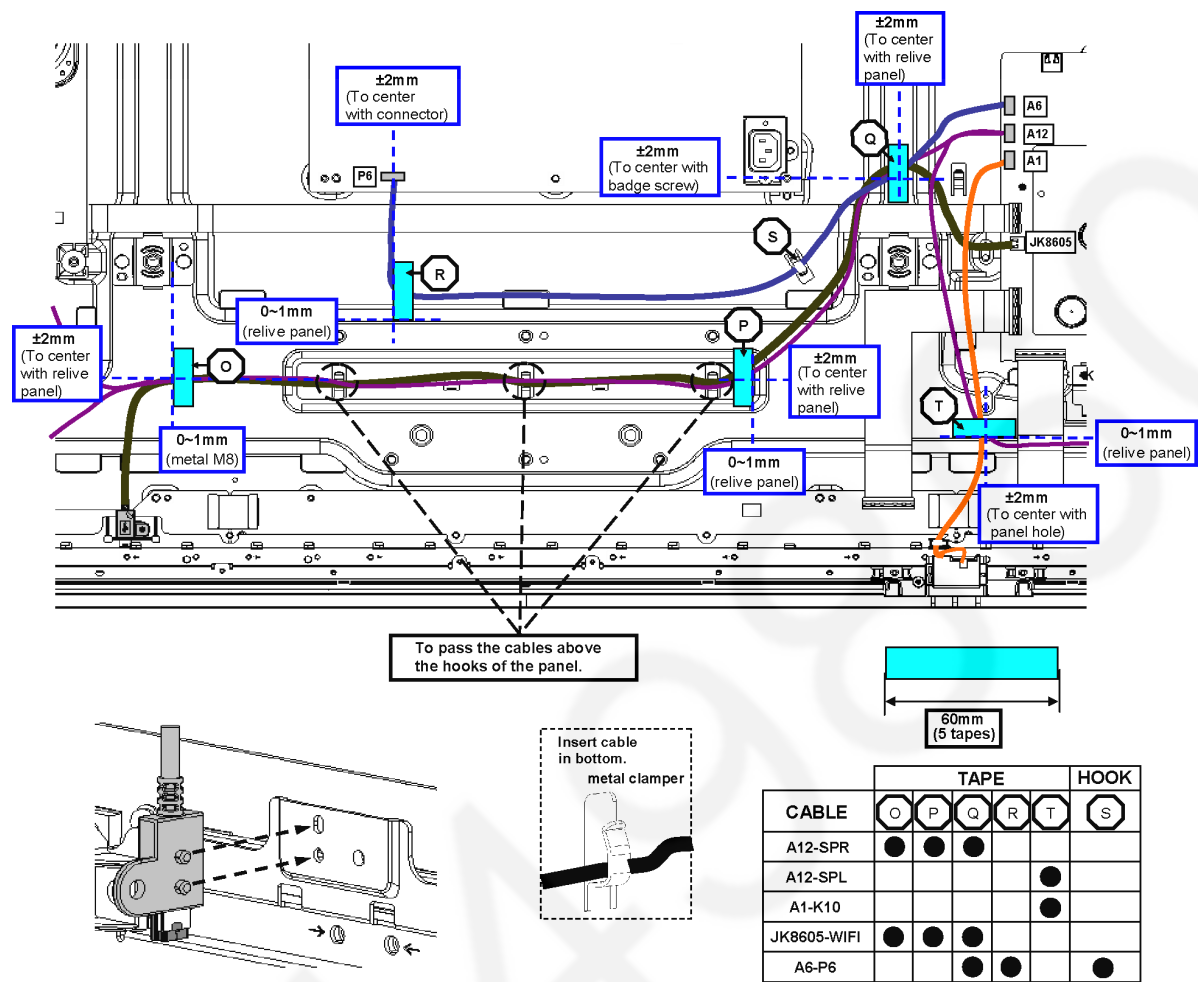
12.5. Wiring (4)



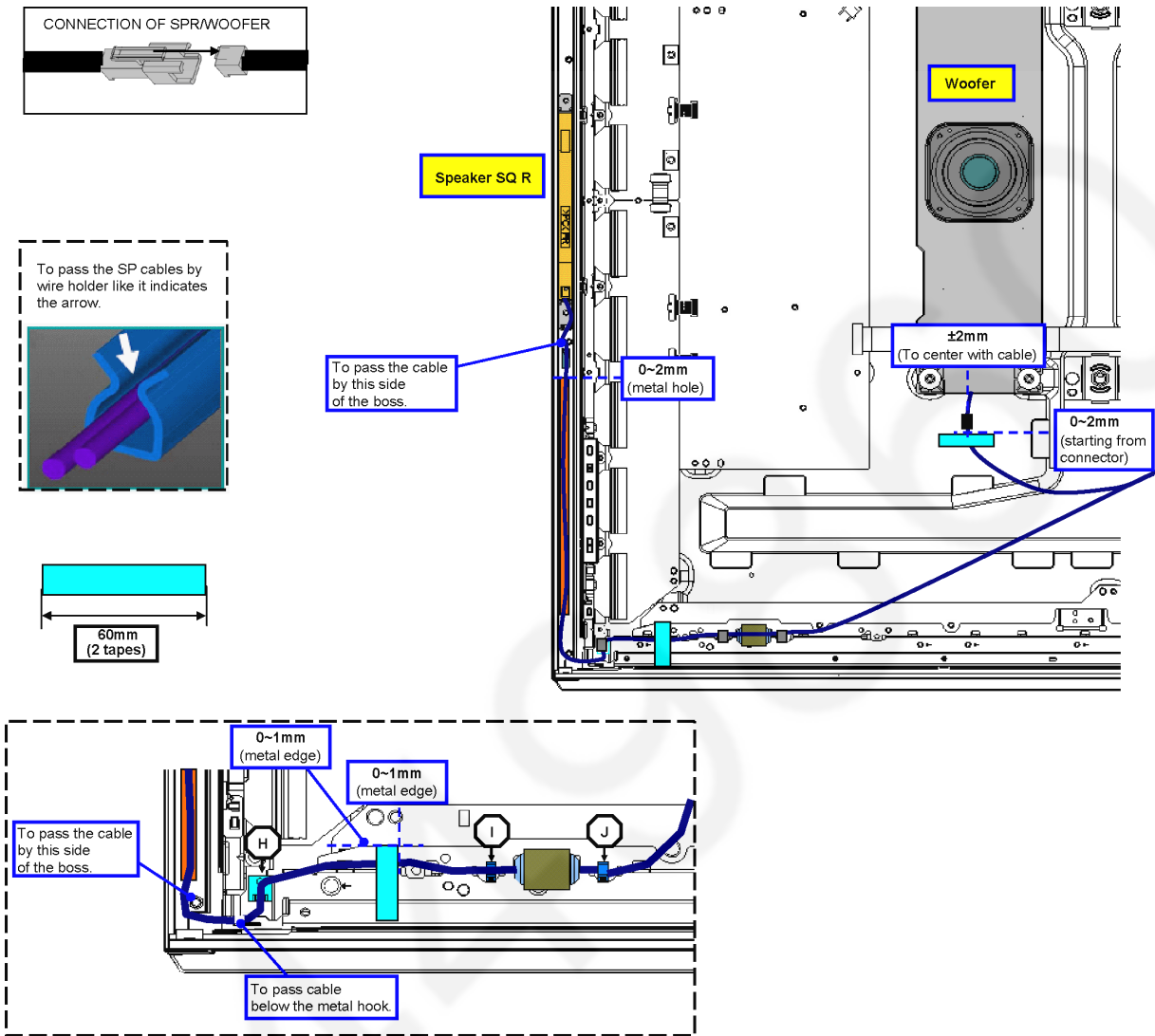
CABLE	TAPE						
	A	B	C	D	E	F	G
SC2-P2	●	●					
P11-SS11					●		●
FAN_A-A8A	●	●	●		●	●	
CAMERA				●	●	●	
FAN_B-A8A						●	



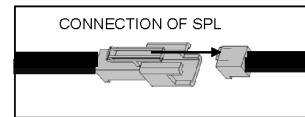
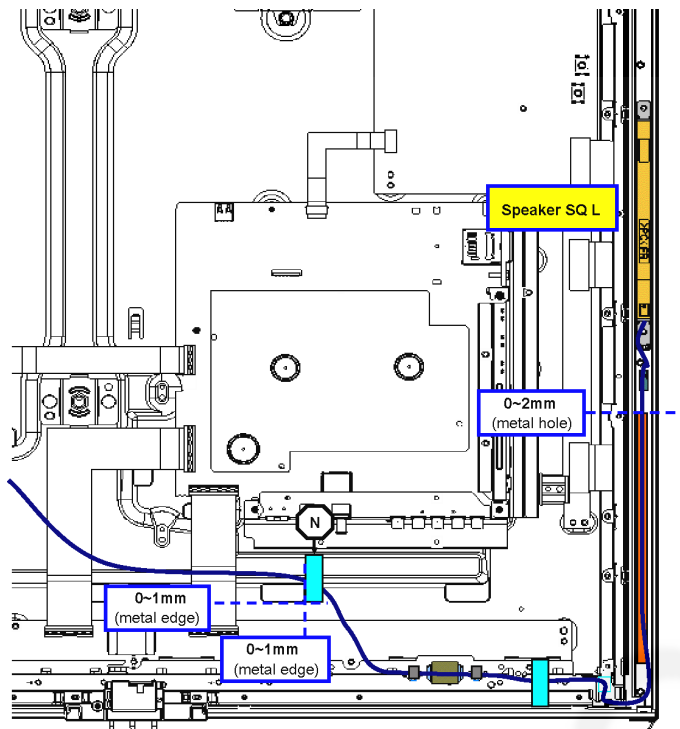
12.6. Wiring (5)



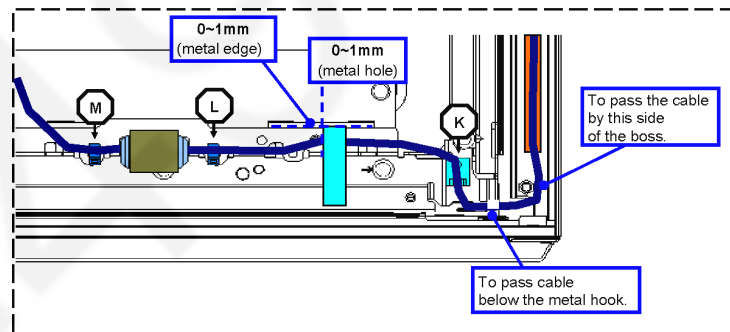
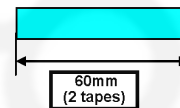
12.7. Wiring (6)



12.8. Wiring (7)



To pass the SP cables by wire holder like it indicates the arrow.



12.9. Wiring (8)

